

Advanced PMU for Microcontrollers and Solid State Drive Applications**BENEFITS and FEATURES**

- **Wide input voltage range**
 - **V_{in} = 2.8V to 5.5V**
- **Complete integrated power solution**
 - **One 4A DC/DC Step-Down (Buck) Regulator**
 - **Three 2.5A DC/DC Step-Down (Buck) Regulators**
 - **One 800mA LDO**
 - **Two 200mA LDOs**
- **Space Savings**
 - **Fully integrated**
 - **High F_{sw} = 2.25MHz or 1.125MHz**
 - **Integrated sequencing**
- **Easy system level design**
 - **Configurable sequencing**
 - **Seamless sequencing with external supplies**
- **Buck 1 Bypass Mode for 3.3V system level compliance**
- **Highly configurable**
 - **uP interface for status reporting and controllability**
 - **Programmable Reset and Power Good GPIO's**
 - **Flexible Sequencing Options**
- **I²C Interface – 1MHz**

APPLICATIONS

- Microcontroller Applications
- Solid-State Drives
- FPGA
- Video Processor

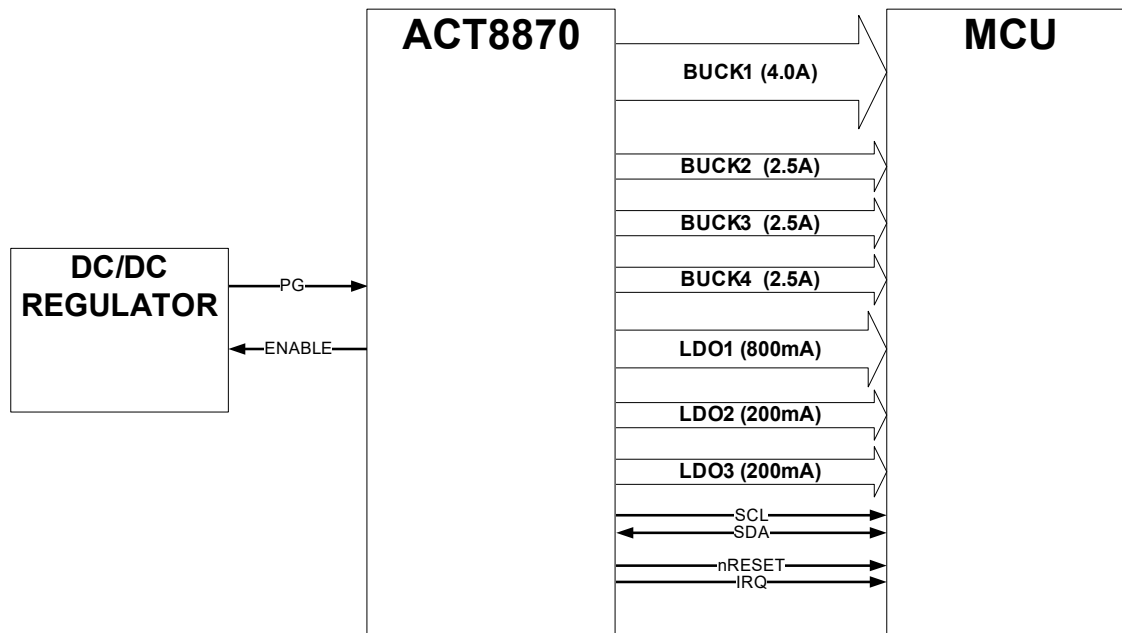
GENERAL DESCRIPTION

The ACT8870 PMIC is an integrated ActivePMU power management unit. It is designed to power a wide range of processors, including Atmel's SAMA5D2, FPGA's, peripherals, microcontrollers, and solid-state drive applications. It is highly flexible and can be reconfigured via I²C for multiple applications without the need for PCB changes. The low external component count and high configurability significantly speeds time to market. Examples of configurable options include output voltage, startup time, slew rate, system level sequencing, switching frequency, sleep modes, operating modes etc. ACT8870 is programmed at the factory with default configuration. These settings can be optimized for a specific design through the I²C interface. The ACT8870 comes in several default configuration. Contact the factory for specific default configurations.

The core of the device includes four DC/DC step down converters using integrated power FETs, three low-dropout regulators (LDOs), and an optional load switch. Each DC/DC regulator switches at 2.25MHz, requiring only three small components for operation. The LDOs only require small ceramic capacitors. All are highly configurable via the I²C interface.

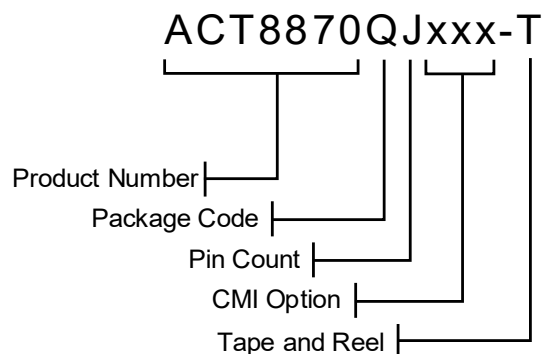
The ACT8870 PMIC is available in a 5 x 5 mm 40 pin QFN package or a 3.2x4.2 mm 0.5mm 48 ball wafer chip-scale package.

Typical Application Diagram



ORDERING INFORMATION

PART NUMBER	V _{OUT1}	V _{OUT2}	V _{OUT3}	V _{OUT4}	V _{LDO1}	V _{LDO2}	V _{LDO3}	Device ID 0x7DFh	Package
ACT8870QJ101-T	Off	1.5V	1.25V	3.3V	3.3V	1.8V	2.5V	0x2Fh	5x5 40 pin
ACT8870QJ102-T	3.3V	1.5V/1.35V	1.2V/1.8V	1.15V	3.3V	1.8V	1.8V	0x0Bh	5x5 40 pin
ACT8870QJ104-T	3.3V	1.5V/1.35V	1.2V/1.8V	1.2V	3.3V	1.8V	1.8V	0x0Dh	5x5 40 pin
ACT8870QJ109-T	2.7V	0.9V	1.2V	1.2V/1.8V	1.8V	1.8V	2.5V	0x12h	5x5 40 pin



Note 1: Standard product options are identified in this table. Contact factory for custom options, minimum order quantity required.

Note 2: All Active-Semi components are RoHS Compliant and with Pb-free plating unless specified differently. The term Pb-free means semiconductor products that are in compliance with current RoHS (Restriction of Hazardous Substances) standards.

Note 3: Package Code designator "Q" represents QFN

Note 4: Pin Count designator "J" represents 40 pins

Note 5: "xxx" represents the CMI (Code Matrix Index) option The CMI identifies the IC's default register settings.

PIN CONFIGURATION - QFN

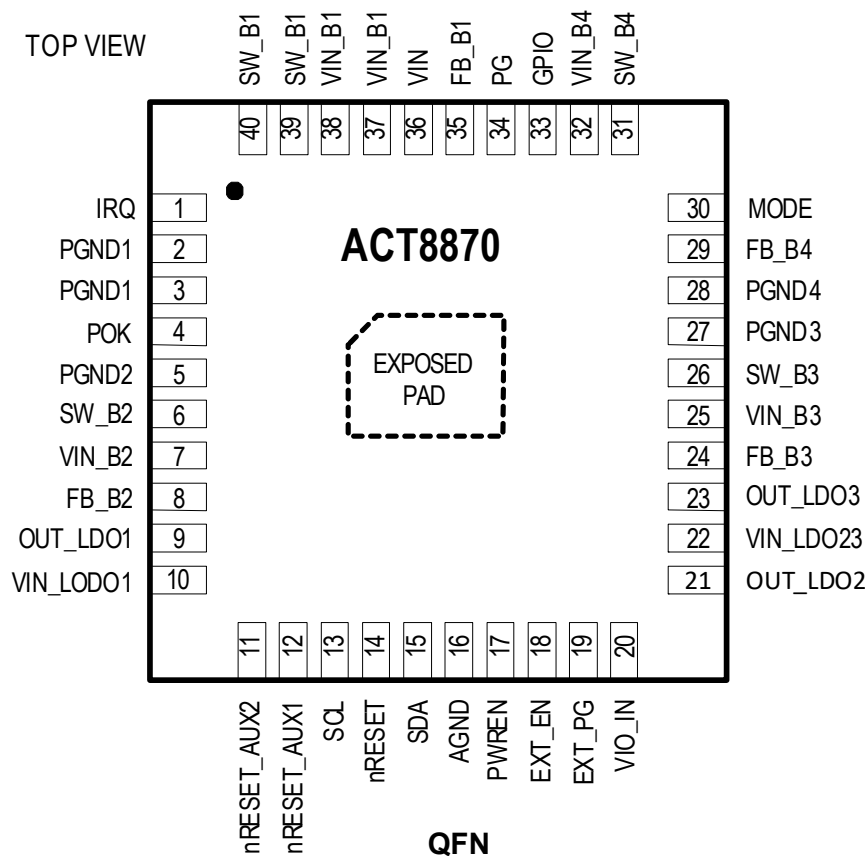


Figure 1: Pin Configuration – Top View – QFN55-40

PIN DESCRIPTIONS - QFN

PIN	NAME	DESCRIPTION
1	IRQ	Interrupt IRQ Open Drain Output indicates a fault occurred.
2,3	PGND1	Dedicated Power Ground for BUCK1 Regulator.
4	POK	Power OK Open Drain Output, indicates Overvoltage or Undervoltage on VIN input supply.
5	PGND2	Dedicated Power Ground for Buck 2 Regulator.
6	SW_B2	Switch Pin for BUCK2 Regulator.
7	VIN_B2	Dedicated VIN power input for BUCK2 Regulator.
8	FB_B2	Feedback for BUCK2 Regulator. Connect to the BUCK2 output.
9	OUT_LDO1	Output for LDO1 Regulator (Leave unconnected if LDO1 is not used and disabled).
10	VIN_LDO1	Dedicated VIN power input for LDO1 Regulator.
11	nRESET_AUX2	Auxiliary nRESET configurable, Open Drain Output (configurable as an input).
12	nRESET_AUX1	Auxiliary nRESET configurable. Open Drain Output (configurable as an input).
13	SCL	I ² C Clock Input.
14	nRESET	nRESET Open Drain Output. This pin is configurable.
15	SDA	I ² C Data Input and Output.
16	AGND	Analog Ground.
17	PWREN	Power Enable Digital Input. This pin is configurable.
18	EXT_EN	External Regulator Enable Push-Pull Digital Output.
19	EXT_PG	External Power Good Digital Input. This pin is configurable.
20	VIO_IN	Digital Input Reference Voltage Input. Connect a 0.1uF ceramic capacitor between VIN_IN and AGND
21	OUT_LDO2	Output for LDO2 Regulator (Leave unconnected if LDO2 is not used and disabled).
22	VIN_LDO23	Dedicated VIN power input for LDO2 and LDO3 Regulator.
23	OUT_LDO3	Output for LDO3 Regulator (Leave unconnected if LDO3 is not used and disabled).
24	FB_B3	Feedback for BUCK3 Regulator. Connect to the BUCK3 output.
25	VIN_B3	Dedicated VIN power input for BUCK3 Regulator.
26	SW_B3	Switch Pin for BUCK3 Regulator.
27	PGND3	Dedicated Power Ground for BUCK3 Regulator.
28	PGND4	Dedicated Power Ground for BUCK4 Regulator.
29	FB_B4	Feedback for BUCK4 Regulator. Connect to the BUCK4 output.
30	MODE	Configuration input pin. This pin is read at power up to configure BUCK1.
31	SW_B4	Switch Pin for BUCK4 Regulator.
32	VIN_B4	Dedicated VIN power input for BUCK4 Regulator.
33	GPIO	Configurable General purpose input/open drain output.
34	PG	Power Good Output. This pin is configurable. Open Drain Output.
35	FB_B1	Feedback for BUCK1 Regulator. Connect to the BUCK1 output.
36	VIN	Analog Input supply monitored by POK thresholds.
37,38	VIN_B1	Dedicated VIN power input for BUCK1 Regulator.
39,40	SW_B1	Switch pin for BUCK1 Regulator.
Exposed Pad		Tie to Ground Plane for best performance

ABSOLUTE MAXIMUM RATINGS

PARAMETER	VALUE	UNIT
All I/O and Power pins except PGND_B1, PGND_B2, PGND_B3, PGND_B4, GND	-0.3 to 6	V
Grounds: Any PGND referenced to GND	-0.3 to +0.3	V
SW_Bx to PGNDx	-0.3 to VIN_Bx + 1	V
FB_Bx to PGNDx	-0.3 to VIN_Bx + 0.3	V
OUT_LDOx to PGNDx	-0.3 to VINx + 0.3	V
EXT_EN, nRESET_AUX1, nRESET_AUX2	-0.3 to VIO_IN + 0.3	V
Junction to Ambient Thermal Resistance, QFN (Note2)	26	°C/W
Junction to Ambient Thermal Resistance, WCSP (Note2)	31	°C/W
Operating Junction Temperature	-40 to 125	°C
Storage Temperature	-55 to 150	°C

Note1: Do not exceed these limits to prevent damage to the device. Exposure to absolute maximum rating conditions for long periods may affect device reliability.

Note2: Measured on Active-Semi Evaluation Kit

RECOMMENDED OPERATING CONDITIONS

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
VIN, VIN_B1, VIN_B2, VIN_B3, VIN_B4, VIN_LDO1, VIN_LDO23		2.8		5.5	V
VIO_IN		1.62		5.5	V
Average lifetime operating current. QFN. (Note 1)	SW_B2, SW_B3, SW_B4 SW_B1			1.6 3.2	A
Operating Junction Temperature		-40		105	°C

Note1: This temperature range is used for lifetime reliability testing.

DIGITAL I/O ELECTRICAL CHARACTERISTICS

($V_{VIO_IN} = 1.8V$, $T_A = 25^\circ C$, unless otherwise specified.)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
PWREN, EXT_PG Input Low	$V_{VIO_IN} = 1.8V$			0.4	V
PWREN, EXT_PG Input High	$V_{VIO_IN} = 1.8V$	1.25			V
PWREN, EXT_PG Input Low	$V_{VIO_IN} = 3.3V$			1.0	V
PWREN, EXT_PG Input High	$V_{VIO_IN} = 3.3V$	2.3			V
POK, IRQ, nRESET, nRESET_AUX1, nRESET_AUX2, GPIO, PG Leakage Current	Output = 5V			1	μA
POK, IRQ, nRESET, nRESET_AUX1, nRESET_AUX2, GPIO, PG Output Low	$I_{OL} = 5mA$			0.35	V
EXT_EN Output Low	$I_{OL} = 1mA$			0.35	V
EXT_EN Output High	$I_{OH} = 1mA$	$V_{VIO_IN} - 0.35$			V
MODE, GPIO Input Low	$V_{AVIN} = 3.3V$			1.0	V
MODE, GPIO Input High	$V_{AVIN} = 3.3V$	2.3			V
MODE, GPIO Input Low	$V_{AVIN} = 5.0V$			1.5	V
MODE, GPIO Input High	$V_{AVIN} = 5.0V$	3.5			V
PWREN, EXT_PG, MODE Deglitch Time			10		μs
V_{VIO_IN} UVLO Threshold Falling				1.2	V

SYSTEM CONTROL ELECTRICAL CHARACTERISTICS

(V_{VIO_IN} = 1.8V, T_A = 25°C, unless otherwise specified.)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Supply Inputs Voltage Range: VIN_B1 referenced to PGND_B1					
VIN_B2 referenced to PGND_B2		2.8		5.5	V
VIN_B3 referenced to PGND_B3					
VIN_B4 referenced to PGND_B4					
VIN_LDO1 referenced to GND		2.4		5.5	V
VIN_LDO23 referenced to GND		2.8		5.5	V
UVLO Threshold Falling (Note 1)	VIN_LVL=0	2.6	2.7	2.8	V
	VIN_LVL=1 UV_LVL=0	2.6	2.7	2.8	V
	VIN_LVL=1 UV_LVL=1	3.7	3.8	3.9	V
UVLO Hysteresis (Note 1)	VIN_LVL=0	50	100	150	mV
	VIN_LVL=1 UV_LVL=0	50	100	150	mV
	VIN_LVL=1 UV_LVL=1	200	300	400	mV
OV Threshold Rising (Note 1)	VIN_LVL = 0	3.6	3.7	3.8	V
	VIN_LVL = 1	5.55	5.75	5.95	V
OV Hysteresis (Note 1)	VIN_LVL = 0	50	100	150	mV
	VIN_LVL = 1	100	150	200	mV
Operating Supply Current	All Regulators Disabled		60		μA
	All Regulators Enabled but no load		300		μA
Thermal Shutdown Temperature TSD_SHUTDWN	Temperature rising	150	165	180	°C
Thermal Shutdown Hysteresis			20		°C
Startup Delay after initial VIN	start of first regulator output assuming start delay=100μsec minimum (Note 2)		435	485	μs
SLEEP Mode exit delay after de-asserting PWREN pin	Configuration dependent (Note 2)	30	38	50	μs
Thermal Interrupt Threshold TSD_ALERT	Temperature rising. Typically 30 degrees lower than TSD_SHUTDWN		135		°C

Thermal Interrupt Hysteresis		15	°C
POK UV Interrupt Threshold Falling (VIN_LVL=0) (Note 3) (Note 4)	POK_UV_SET=00 (88% of 3.3V) POK_UV_SET=01 (86% of 3.3V) POK_UV_SET=10 (84% of 3.3V) POK_UV_SET=11 (Disable)	2.80 2.90 3.00 2.74 2.84 2.94 2.67 2.77 2.87 N/A N/A N/A	V
POK UV Interrupt Threshold Falling (VIN_LVL=1) (Note 3) (Note 4)	POK_UV_SET=00 (88% of 3.3V) POK_UV_SET=01 (85% of 3.3V) POK_UV_SET=10 (85% of 5.0V) POK_UV_SET=11 (Disable)	2.80 2.90 3.00 2.70 2.80 2.90 4.08 4.25 4.42 N/A N/A N/A	V
POK OV Interrupt Threshold Rising (VIN_LVL=0) (Note 3) (Note 4)	POK_OV_SET=00 (107% of 3.3V) POK_OV_SET=01 (109% of 3.3V) POK_OV_SET=10 (110% of 3.3V) POK_OV_SET=11 (Disable)	3.43 3.53 3.63 3.50 3.60 3.70 3.53 3.63 3.73 N/A N/A N/A	V
POK OV Interrupt Threshold Rising (VIN_LVL=1, POK_LVL = 0) (Note 3) (Note 4)	POK_OV_SET=00 (133% of 3.3V) POK_OV_SET=01 (136% of 3.3V) POK_OV_SET=10 (136% of 3.3V) POK_OV_SET=11 (Disable)	4.23 4.40 4.57 4.33 4.50 4.67 4.33 4.50 4.67 N/A N/A N/A	V
POK OV Interrupt Threshold Rising (VIN_LVL=1, POK_LVL = 1) (Note 3) (Note 4)	POK_OV_SET=00 (110% of 5.0V) POK_OV_SET=01 (112% of 5.0V) POK_OV_SET=10 (114% of 5.0V) POK_OV_SET=11 (Disable)	5.33 5.50 5.67 5.43 5.60 5.77 5.53 5.70 5.87 N/A N/A N/A	V
POK Deglitch Time OV or UV		5	µs

Note 1: All Under-voltage Lockout, Overvoltage measurements are referenced to the AVIN Input and GND Pins.

Note 2: This delay can be affected by programming sequence and startup delays.

Note 3: All POK Under-voltage and Overvoltage measurements are referenced to the VIN Input and GND Pins.

Note 4: There is no hysteresis on OV and UV threshold for the POK interrupt.

INTERNAL STEP-DOWN DC/DC ELECTRICAL CHARACTERISTICS REGULATOR: (BUCK1)

(VIN_B1 = 5V, TA = 25°C, unless otherwise specified.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Input Operating Voltage Range		2.8		5.5	V
Output Voltage Range	Configurable in 12.5mV steps	0.8		4.0	V
Standby Supply Current, Low Power Mode Enabled	VOUT_B1 = 103%, Regulator Enabled, No Load		45		μA
Shutdown Current	Regulator Disabled			1	μA
Output Voltage Accuracy – Default Voltage - PWM Mode	VOUT_B1 = 3.3V, IOUT = 2A	-1%	VNOM	1%	V
Output Voltage Accuracy – Default Voltage - PFM Mode	VOUT_B1 = 3.3V, IOUT = 1mA	-1%	VNOM	1%	V
Line Regulation	VOUT_B1 = 2.8V VIN_B1 = 3.3V to 5.5V, PWM Regulation		0.02		%/V
Load Regulation	VOUT_B1 = 3.3V PWM Regulation		0.04		%/A
Power Good Threshold	VOUT_B1 Rising	92	93	94	%VNOM
Power Good Hysteresis	VOUT_B1 Falling		3		%VNOM
Overvoltage Fault Threshold	VOUT_B1 Rising	107.5	110	112.5	%VNOM
Overvoltage Fault Hysteresis	VOUT_B1 Falling		3		%VNOM
Switching Frequency	VOUT_B1 ≥ 20% of VNOM	1.075	1.125	1.180	MHz
Programmable Soft-Start Time, TSET	Configurable 10% to 90% VNOM	300		1000	μs
Soft-Start Time Tolerance	Tolerance from TSET	-25		+25	%
High Side FET Peak Current Limit (Cycle-by-Cycle) ILIMSET	B1_ILIMSET=11 B1_ILIMSET=10 B1_ILIMSET=01 B1_ILIMSET=00		3.0 3.8 4.6 5.3		A
High Side FET Peak Current Limit (Cycle-by-Cycle) Tolerance	At default ILIMSET	-10	ILIMSET	+10	%
	At other set points	-15	ILIMSET	+15	%
High Side FET Peak Current Limit, IRQ Trigger Level	Below ILIMSET = 00, 01, 10	-30.0	-22.5	-15.0	%
	Below ILIMSET = 11	-32.5	-22.5	-12.5	%
High Side FET Peak Current Limit, Shutdown Level	Above ILIMSET = 00, 01, 10	+15.0	+22.5	+30	%
	Above ILIMSET = 11	+12.5	+22.5	+32.5	%
PMOS On-Resistance	ISW = -1A, VIN = 5.0V		0.025	0.04	Ω
NMOS On-Resistance	ISW = 1A, VIN = 5.0V		0.025		Ω
SW Leakage Current	VIN_B1 = 5.5V, VSW = 0 or 5.5V			1	μA

Dynamic Voltage Scaling Rate	B1_SLEW=00 (not allowed) B1_SLEW=01 B1_SLEW=10 B1_SLEW=11	N/A 14.0 3.50 0.88	mV/us
Switching Rise / Fall Times	B1_DRVADJ=00 $V_{IN_B1} = 5V$ B1_DRVADJ=01 B1_DRVADJ=10 B1_DRVADJ=11	6.3/9.0 4.5/7.4 3.1/5.9 3.0/5.0	ns
Discharge Resistance	Enabled when regulator disabled	2.75 4.4 8.75	Ω

INTERNAL STEP-DOWN DC/DC ELECTRICAL CHARACTERISTICS REGULATOR: (BUCK1) – BYPASS MODE

 (VIN_B1 = 3.3V, T_A = 25°C, unless otherwise specified.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Bypass Mode					
Input Voltage for By-Pass Mode		2.7	3.3	3.7	V
PMOS On-Resistance	I _{SW} = -1A, VIN = 3.3V Max=125°C at T _{Junction}		0.025	0.04	Ω
Internal PMOS Current Detection	Triggers Interrupt on IRQ Pin	1.4	3	4.6	A
Internal PMOS Current Detection Deglitch Time			10		μs
Internal PMOS Current Shutdown	Shuts down after deglitch time and stays off for Off Time	5.4	6.0	6.6	A
Internal PMOS Current Shutdown Deglitch Time			10		μs
Internal PMOS Current Shutdown Off time			100		ms
Internal PMOS Softstart	Only used with 3.3V Input	5.94	6.6	7.26	mV/us

INTERNAL STEP-DOWN DC/DC ELECTRICAL CHARACTERISTICS REGULATOR: (BUCK2-4)

(VIN_Bx = 5V, TA = 25°C, unless otherwise specified.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Input Operating Voltage Range		2.8		5.5	V
Output Voltage Range	Configurable in 12.5mV steps	0.8		4	V
Maximum Output Current		2			A
Standby Supply Current, Low Power Mode Enabled	VOUT_Bx = 103%, Regulator Enabled, No load		35		μA
Shutdown Current	VIN_Bx = 5.5V, Regulator Disabled		0.1	1	μA
B2 Voltage Accuracy – Default Voltage – PWM Mode	CMI101 VOUT_B2 = 1.5V, IOUT = 1A	-1%	VNOM	1%	V
B3 Voltage Accuracy – Default Voltage – PWM Mode	CMI101 VOUT_B3 = 1.25V, IOUT = 1A	-1%	VNOM	1%	V
B4 Voltage Accuracy – Default Voltage – PWM Mode	CMI101 VOUT_B4 = 3.3V, IOUT = 1A	-1%	VNOM	1%	V
B2 Voltage Accuracy – Default Voltage – PFM Mode	CMI101 VOUT_B2 = 1.5V, IOUT = 1A	-1%	VNOM	1%	V
B3 Voltage Accuracy – Default Voltage – PFM Mode	CMI101 VOUT_B3 = 1.25V, IOUT = 1A	-1%	VNOM	1%	V
B4 Voltage Accuracy – Default Voltage – PFM Mode	CMI101 VOUT_B4 = 3.3V, IOUT = 1A	-1%	VNOM	1%	V
Line Regulation	VOUT_Bx = 1.8V VIN_Bx = 2.8V to 5.5V PWM Regulation		0.02		%/V
Load Regulation	VOUT_Bx = 1.8V PWM Regulation		0.04		%/A
Power Good Threshold	VOUT_B2 Rising	92	93	94	%VNOM
	VOUT_B3 Rising	94	95	96	
	VOUT_B4 Rising	94	95	96	
Power Good Hysteresis	VOUT_Bx Falling		3		%VNOM
Overvoltage Fault Threshold	VOUT_Bx Rising	107.5	110	112.5	%VNOM
Overvoltage Fault Hysteresis	VOUT_Bx Falling		3		%VNOM
Switching Frequency	VOUT_Bx ≥ 20% of VNOM	2.15	2.25	2.36	MHz
Programmable Soft-Start Time, TSET	Configurable 10% to 90% VNOM	300		1000	μs
Soft-Start Time Tolerance	Tolerance from TSET	-25		+25	%
High Side FET Current Limit (Cycle-by-Cycle) ILIMSET	Bx_ILIMSET=11 Bx_ILIMSET=10 Bx_ILIMSET=01 Bx_ILIMSET=00		2.0 2.5 3.0 3.5		A
High Side FET Current Limit (Cycle-by-Cycle) Tolerance	At default ILIMSET	-10	ILIMSET	+10	%
	At other setpoints	-15	ILIMSET	+15	%
High Side FET Peak Current Limit, IRQ	Below ILIMSET = 00, 01, 10	-27.5	-22.5	-17.5	%

Trigger Level	Below ILIMSET = 11	-30.0	-22.5	-15.0	%
High Side FET Peak Current Limit, Shutdown Level	Above ILIMSET = 00, 01, 10	+15.0	+22.5	+30	%
	Above ILIMSET = 11	+12.5	+22.5	+32.5	%
PMOS On-Resistance	I _{SW} = -500mA	0.08			Ω
NMOS On-Resistance	I _{SW} = 500mA	0.05			Ω
SW Leakage Current	V _{VIN_BX} = 5.5V, V _{SW} = 0 or 5.5V	1			μA
Dynamic Voltage Scaling Rate	Bx_SLEW=00 Bx_SLEW=01 Bx_SLEW=10 Bx_SLEW=11	Not Allowed 14.0 3.50 0.88			mV/us
Switching Rise / Fall Times	Bx_DRVADJ=00 V _{IN_Bx} = 5V Bx_DRVADJ=01 Bx_DRVADJ=10 Bx_DRVADJ=11	6.3/9.0 4.5/7.4 3.1/5.9 3.0/5.0			ns
Discharge Resistance	Enabled when regulator disabled	6.25	9.40	20	Ω

LDO1 ELECTRICAL CHARACTERISTICS

(VIN_LDO1 = 5V, TA = 25°C, unless otherwise specified.)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Operating Voltage Range		2.4		5.5	V
Output Voltage Range–VSET	Configurable in 25mV steps	0.8		4.0	V
Output Current	VIN_LDO1 = 2.8V to 5.5V, LDO1_ILIM=11	0.75			A
Output Current	VIN_LDO1 = 2.4V to 2.8V, LDO1_ILIM=1x	0.4			A
Output Voltage Accuracy	VIN_LDO1 - V_LDO1_OUT > 0.4V	-1	VSET	1	%
Line Regulation	VIN_LDO1 - V_LDO1_OUT > 0.4V VIN_LDO1 = 2.8V to 5.5V ILO1_OUT = 1mA		0.005		% / V
Load Regulation	ILO1_OUT = 1mA to 750mA, LDO1_ILIM=11		0.15		% / A
Power Supply Rejection Ratio	f = 1kHz, ILO1_OUT = 20mA, V_LDO1_OUT = 2.5V		54		dB
	f = 10kHz, ILO1_OUT = 20mA, V_LDO1_OUT = 2.5V		53		
	f = 2.25MHz, ILO1_OUT = 20mA, V_LDO1_OUT = 2.5V		44		
Supply Current per Output	Regulator Enabled No Load		25	42	µA
	Regulator Disabled		0	1	
Soft-Start Period	V_LDO1_OUT = 1.8V Setting (10% to 90%) LDO1_SS_RAMP=00 LDO1_SS_RAMP=01 LDO1_SS_RAMP=10 LDO1_SS_RAMP=11		240 330 450 575		µs
	V_LDO1_OUT = 2.5V Setting (10% to 90%) LDO1_SS_RAMP=00 LDO1_SS_RAMP=01 LDO1_SS_RAMP=10 LDO1_SS_RAMP=11		Not allowed 385 465 600		
	V_LDO1_OUT = 3.3V Setting (10% to 90%) LDO1_SS_RAMP=00 LDO1_SS_RAMP=01 LDO1_SS_RAMP=10 LDO1_SS_RAMP=11		Not allowed 450 525 660		
Power Good Threshold	V_LDO1_OUT Rising	92	93	94	%VNOM
Power Good Hysteresis	V_LDO1_OUT Falling		3		%VNOM
Overvoltage Fault Threshold	V_LDO1_OUT Rising	105	110	114	%VNOM
Overvoltage Fault Hysteresis	V_LDO1_OUT Falling		3		%VNOM
Discharge Resistance		10	25	75	Ω
Dropout Voltage	ILO1_OUT = 200mA			200	mV
Dropout Voltage	ILO1_OUT = 400mA, LDO1_ILIM=1x			300	mV
Dropout Voltage	ILO1_OUT = 750mA VIN_LDO1 > 2.8 LDO_ILIM=11			400	mV
Output Current Limit	LDO1_ILIM=00 LDO1_ILIM=01 LDO1_ILIM=10 LDO1_ILIM=11 (800mA min)	-15%	350 500 630 1000	+15%	mA
Startup Delay	Additional startup delay required before soft start ramp LDO1_SS_RAMP=00	31	44	65	µs

LDO2 AND LDO3 ELECTRICAL CHARACTERISTICS

(VIN_LDO23 = 5V, TA = 25°C, unless otherwise specified.)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Operating Voltage Range		2.4		5.5	V
Output Voltage Range – VSET	Configurable in 25mV steps	0.8		4.0	V
Output Voltage Accuracy	VIN_LDO23 - VLDOX_OUT > 0.4V	-1	VSET	1	%
Line Regulation	VIN_LDO23 - VLDOX_OUT > 0.4V VIN_LDO23 = 2.8V to 5.5V ILDOX_OUT = 1mA		0.007		% / V
Load Regulation	ILDOX_OUT = 1mA to 100mA, LDOX_ILIM=1X		-1		% / A
Power Supply Rejection Ratio	f = 1kHz, ILDOX_OUT = 20mA, VLDOX_OUT = 1.8V		56		dB
	f = 10kHz, ILDOX_OUT = 20mA, VLDOX_OUT = 1.8V		45		
	f = 2.25MHz, ILDOX_OUT = 20mA, VLDOX_OUT = 1.8V		55		
Supply Current per Output	Regulator Disabled		0.02	1	μA
Supply Current per Output	Regulator Enabled, No load		15		μA
Soft-Start Period	VLDOX_OUT = 1.8V Setting (10% to 90%) LDO23 SS_RAMP=00 LDO23 SS_RAMP=01 LDO23 SS_RAMP=10 LDO23 SS_RAMP=11		110 110 165 215		μs
	VLDOX_OUT = 2.5V Setting (10% to 90%) LDO23 SS_RAMP=00 LDO23 SS_RAMP=01 LDO23 SS_RAMP=10 LDO23 SS_RAMP=11		145 145 175 215		
	VLDOX_OUT = 3.3V Setting (10% to 90%) LDO23 SS_RAMP=00 LDO23 SS_RAMP=01 LDO23 SS_RAMP=10 LDO23 SS_RAMP=11		200 200 210 235		
Power Good Threshold	VLDOX_OUT Rising	91	93	95	%VNOM
Power Good Hysteresis	VLDOX_OUT Falling		3		%VNOM
Overvoltage Fault Threshold	VLDOX_OUT Rising	105	110	114	%VNOM
Overvoltage Fault Hysteresis	VLDOX_OUT Falling		3		%VNOM
Discharge Resistance		20	50	125	Ω
Dropout Voltage	ILDOX_OUT = 30mA		50	90	mV
Dropout Voltage	ILDOX_OUT = 50mA, LDOX_ILIM=01		90	150	mV
Dropout Voltage	ILDOX_OUT = 100mA, LDOX_ILIM=1x		180	310	mV
Dropout Voltage	ILDOX_OUT = 150mA VIN_LDO23 > 2.8 LDOX_ILIM=11		285	500	mV

Output Current Limit	LDOx_ILIM=00 LDOx_ILIM=01 LDOx_ILIM=10 LDOx_ILIM=11	60 100 150 200	80 145 225 290	mA
Startup Delay	Additional startup delay required before soft start ramp LDOx_SS_RAMP=01	20	36	55
				μs

OVERALL SYSTEM TIMING REQUIREMENTS

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Regulator Programmable Startup Delay Timings between turn on events	ONDLY=000 ONDLY=001 ONDLY=010 ONDLY=011 ONDLY=100 ONDLY=101 ONDLY=110 ONDLY=111	32.6 101 196 291 386 481 576 671	34.5 106.5 206.5 306.5 406.5 506.5 606.5 706.5	51.5 127.5 132.5 337.5 442.5 547.5 652.5 757.5	μs
nRESET, nRESET_AUX2 Programmable Delay Range	Step Size = 114μs	199		996	μs
nRESET, nRESET_AUX2 Min Delay Timing	Setting nRST_DLY=000	160	199	240	μs
nRESET, nRESET_AUX2 Max Delay Timing	Setting nRST_DLY=111	920	996	1080	μs
nRESET_AUX1 Delay Timings Programmable Delay Range	Step Size = 228μs	398		1991	μs
nRESET_AUX1 Min Delay Timing	Setting nRST_AUX1_DLY=000	360	398	435	μs
nRESET_AUX1 Max Delay Timing	Setting nRST_AUX1_DLY=111	1876	1991	2114	μs
AUX TIMER Delay Timing	Setting AUX_DLY=00 Setting AUX_DLY=01 Setting AUX_DLY=10 Setting AUX_DLY=11	3.7 7.7 15.7 31.7	4 8 16 32	4.3 8.3 16.3 32.3	ms

I²C INTERFACE ELECTRICAL CHARACTERISTICS

(V_{IO_IN} = 1.8V, T_A = 25°C, unless otherwise specified.)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SCL, SDA Input Low	V _{IO_IN} = 1.8V			0.4	V
SCL, SDA Input High	V _{IO_IN} = 1.8V	1.25			V
SCL, SDA Input Low	V _{IO_IN} = 3.3V			1.0	V
SCL, SDA Input High	V _{IO_IN} = 3.3V	2.3			V
SDA Leakage Current	SDA=5V			1	μA
SDA Output Low	I _{OL} = 5mA			0.35	V
SCL Clock Frequency, f _{SCL}		0		1000	kHz
SCL Low Period, t _{LOW}		0.5			μs
SCL High Period, t _{HIGH}		0.26			μs
SDA Data Setup Time, t _{SU}		50			ns
SDA Data Hold Time, t _{HD}	(Note1)	0			ns
Start Setup Time, t _{ST}	For Start Condition	260			ns
Stop Setup Time, t _{SP}	For Stop Condition	260			ns
Capacitance on SCL or SDA Pin				10	pF
SDA Fall Time SDA, T _{of}	Device requirement			120	ns
Pulse Width of spikes must be suppressed on SCL and SDA		0		50	ns

Note1: Comply to I²C timings for 1MHz operation - "Fast Mode Plus".

Note2: No internal timeout for I²C operations, however, I²C communication state machine will be reset when entering RESET, IDLE, OVUVFLT, and THERMAL states to clear any transactions that may have been occurring when entering the above states.

Note3: This is an I²C system specification only. Rise and fall time of SCL & SDA not controlled by the device.

Note4: Device Address is 7'h5A

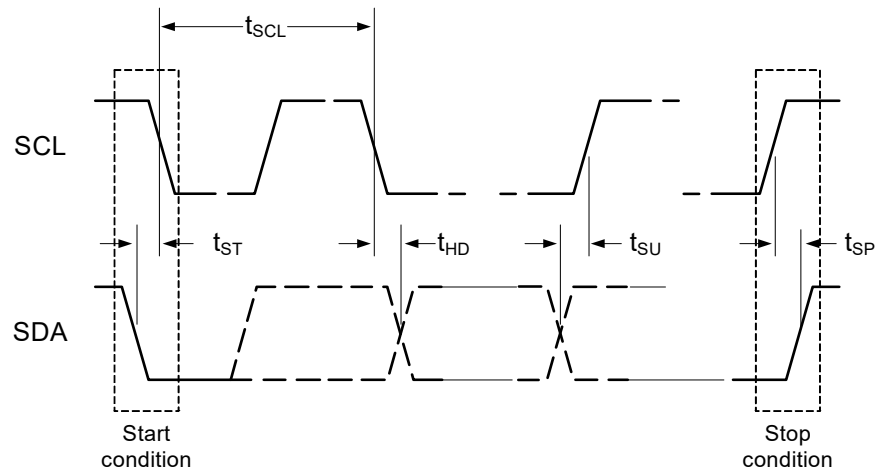


Figure 2: I²C Data Transfer

SYSTEM CONTROL INFORMATION

General

The ACT8870 is a single-chip integrated power management solution designed to power many processors such as the Atmel SAMA5D3. It integrates four highly efficient buck regulators, three LDOs, and an integrated load bypass switch. Its high integration and high switching frequency result in an extremely small footprint and lost power solution. It contains a master controller that manages startup sequencing, timing, voltages, slew rates, sleep states, and fault conditions. I²C configurability allows system level changes without the need for costly PCB changes. The built-in load bypass switch enables full sequencing configurability in 3.3V systems.

The ACT8870 master controller monitors all outputs and reports faults via I²C and hardwired status signals. Faults can be masked and fault levels and responses are configurable via I²C.

Many of the ACT8870 pins and functions are configurable. The IC's default functionality is defined by the default CMI (Code Matrix Index), but much of this functionality can be changed via I²C. The first part of the datasheet describes basic IC functionality and default pin functions. The end of the datasheet provides the configuration and functionality specific to each CMI version. Contact sales@active-semi.com for additional information about other configurations.

I²C Serial Interface

To ensure compatibility with a wide range of systems, the ACT8870 uses standard I²C commands. The ACT8870 operates as a slave device, and is addressed using a 7-bit slave address followed by an eighth bit, which indicates whether the transaction is a read-operation or a write-operation. As an example, the 7-bit slave address 0x5Ah follows the format 1011010x where "x" is a 0 for write operation and 1 for a read operation. This results in 0xB4h for write operations and 0xB5h for read operations.

There is no timeout function in the I²C packet processing state machine, however, any time the I²C state machine receives a start bit command, it immediately resets the packet processing, even if it is in the middle of a valid packet.

The ACT8870 holds the I²C state machine in reset during the RESET, Idle, OVUVFLT, and THERMAL states to avoid a corruption of registers when the voltage regulators are out of spec.

I²C commands are communicated using the SCL and SDA pins. SCL is the I²C serial clock input. SDA is the data input and output. SDA is open drain and must have a pullup resistor. Signals on these pins must meet timing requirements in the Electrical Characteristics Table.

I²C Registers

The ACT8870 contains an array of internal registers that contain the IC's basic instructions for setting up the IC configuration, output voltages, sequencing, fault thresholds, fault masks, etc. These registers are what give the IC its operating flexibility. The two types of registers are described below.

Basic Volatile – These are R/W (Read and Write) and RO (Read only). After the IC is powered, the user can modify the R/W register values to change IC functionality. Changes in functionality include things like masking certain faults. The RO registers communicate IC status such as fault conditions. Any changes to these registers are lost when power is recycled. The default values are fixed and cannot be changed by the factory or the end user.

Basic Non-Volatile – These are R/W and RO. After the IC is powered, the user can modify the R/W register values to change IC functionality. Changes in functionality include things like output voltage settings, startup delay time, and current limit thresholds. Any changes to these registers are lost when power is recycled. The default values can be modified at the factory to optimize IC functionality for specific applications. Please consult sales@active-semi.com for custom options and minimum order quantities.

When modifying only certain bits within a register, take care to not inadvertently change other bits. Inadvertently changing register contents can lead to unexpected device behavior.

State Machine

The ACT8870 contains an internal state machine with five internal states.

RESET State

In the RESET, or "cold" state, the ACT8870 is waiting for the input voltage on VIN to be within a valid range defined by I²C bits POK_OV_SET and POK_UV_SET. All regulators are off in RESET. nRESET, nRESET_AUX1, and nRESET_AUX2 are asserted low. All volatile registers are reset to defaults and Non-Volatile registers are reset to programmed defaults. The IC transitions from RESET to ACTIVE when the input voltage enters the valid range. The IC transitions from any other state to RESET if the input voltage drops below the UVLO threshold voltage.

ACTIVE State

The ACTIVE state is the normal operating state when the input voltage is within the allowable range, all outputs are turned on, and no faults are present. When en-

tering the ACTIVE state from the RESET state, all regulators are powered on following their programmed power up sequence. The regulators are not sequenced when entering ACTIVE from SLEEP.

SLEEP State

The SLEEP state is a low power mode for the operating system. Each output can be programmed to be on or off in the SLEEP state. The outputs do not follow any sequencing when turning on or off as they enter or exit the SLEEP state. They do turn on with their programmed softstart time. Buck1/2/3/4 can be programmed to regulate to their VSET0 voltage, VSET1 voltage, or be turned off in the SLEEP state. LDO1/2/3 can be programmed to regulate to their VSET0 voltage or can be programmed to be turned off. Note that LDO1/2/3 do not have a VSET1 voltage.

The IC can enter SLEEP via a hardware input pin or an I²C command. The hardware input is typically the PWREN pin, but this can be reconfigured to other pins. To enable SLEEP via I²C, program the following:

Set register 0x08h bit1 (PWR_DN_MODE) = 1

Set register 0x00h bit0 (PWRDN_EN) = 1

To enter SLEEP, program register 0x01h bit1 (SLP_ENTR) = 1.

I²C is disabled in SLEEP mode, to the only way to exit SLEEP mode is to toggle the PWREN pin.

THERMAL State

In the THERMAL state the chip has exceeded the thermal shutdown temperature. To protect the device, all the regulators are shut down and all three nRESETx pins are asserted low. This state can be disabled by setting register 0x0Ah bit4 (TSD_nMASK) = 0. Note that thermal shutdown fault flag, TSD_SHUTDOWN, still provides the thermal status even TSD_nMASK = 0.

OVUVFLT State

In the OVUVFLT state one of the regulators has exceed an OV level at any time or UV level after the soft start ramp has completed. All regulators shutdown and all three nRESETx outputs are asserted low when the IC enters OVUVFLT state. The OVUVFLT state is timed to retry after 100ms and enter the ACTIVE state. If the OV or UV condition still exists in the ACTIVE state the IC returns back to the OVUVFLT state. The cycle continues until the OV or UV fault is removed or the input power is removed. This state can be disabled by setting the OV_nMASK or UV_nMASK non-volatile bits low. The IC does not directly enter OVUVFLT in an overcurrent condition, but does enter this state due to the resulting UV condition.

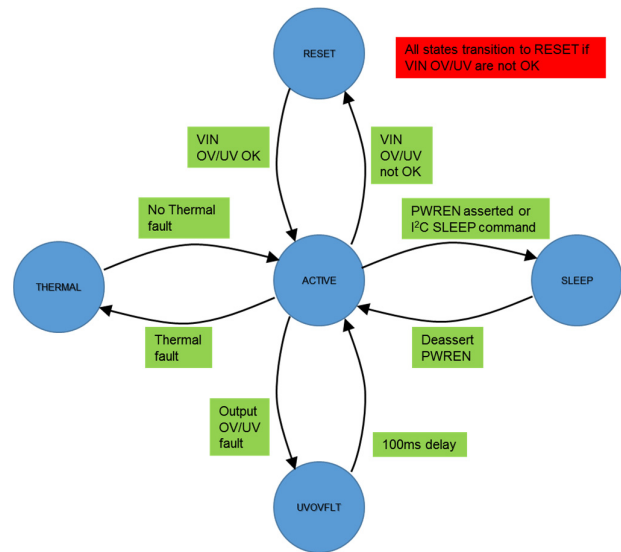


Figure 3. State Machine

Sequencing

The ACT8870 provides the end user with extremely versatile sequencing capability that can be optimized for many different applications. Each of the seven outputs has four basic sequencing parameters: input trigger, turn-on delay, softstart time, and output voltage. Each of these parameters is controlled via the ICs internal registers. As an example, the ACT8870QJ101-T sequencing and output voltages are optimized for the Atmel SAMA5D3D3 processor. The specifics for this IC as well as others are detailed at the end of the datasheet. Contact sales@active-semi.com for custom sequencing configurations. Refer to the Active-Semi Application Note describing the Register Map for full details on I²C functionality and programming ranges.

Input trigger. The input trigger for a regulator is the event that turns that regulator on. Each output can have a separate input trigger. The input trigger can be the internal power ok (POK) signal from one of the other regulators, the internal VIN POK signal, or an external signal applied to an input pin such as EXT_PG or GPIO. This flexibility allows a wide range of sequencing possibilities, including have some of the outputs be sequenced with another external power supply or a control signal from the host. As an example, if the LDO1 input trigger is Buck1, LDO1 will not turn on until Buck1 is in regulation. Input triggers are defined at the factory and can only be changed with a custom CMI configuration. The nRESETx, POK, PG, and EXT_EN outputs can be connected to a power supply's internal POK signal and used to trigger external supplies in the overall sequencing scheme.

Turn-on Delay. The turn-on delay is the time between an input trigger going active and the output starting to turn on. Each output's turn-on delay is configured via its I²C bit ONDLY. Turn-on delays can be changed after the IC is powered on, but they are volatile and reset to the factory defaults when power is recycled.

Softstart Time. The softstart time is the time it takes an output to ramp from 0V to its programmed voltage. Each output's softstart time is configured via its I²C bit SS_RAMP. Softstart times can be changed after the IC is powered on, but they are volatile and reset to the factory defaults when power is recycled.

Output Voltage. The output voltage is each regulator's desired voltage. Each buck's output voltage is programmed via its I²C bits Bx_VSET0 and Bx_VSET1. The output regulates to Bx_VSET0 in ACTIVE mode. They can be programmed to regulate to Bx_VSET1 in DVS mode or SLEEP mode. Each output's voltage can be changed after the IC is powered on, but the new setting is volatile and is reset to the factory defaults when power is recycled. Output voltages can be changed on the fly. If a large output voltage change is required, it is best to make multiple smaller changes. This prevents the IC from detecting an instantaneous over or under voltage condition because the fault threshold are immediately changed, but the output takes time to respond.

Dynamic Voltage Scaling

On-the-fly dynamic voltage scaling (DVS) for the four buck converters is available via the I²C interface. This allows systems to save power by quickly adjusting the microprocessor performance level when the workload changes. Note that DVS is not a different operating state. The IC operates in the ACTIVE state, but just regulates the outputs to a different voltage. For fault free operation, the user must ensure output load conditions plus the current required to charge the output capacitance during a DVS rising voltage condition does not exceed the current limit setting of the regulator. As with any power supply, changing an output voltage too fast can require a current higher than the current limit setting. The user must ensure that the voltage step, slew rate, and load current conditions do not result in an instantaneous loading that results in a current limit condition.

Enter DVS by programming register 0x00h bit1 (DVS_EN) = 1 and then pulling the EXT_EN pin high. Note that some CMI configurations may not require DVS_EN = 1 and may use different input pins.

Fault Protection

The ACT8870 contains several levels of fault protection, including the following:

Output Overvoltage

Output Undervoltage

Output Current Limit

Thermal Warning

Thermal Shutdown

There are three types of I²C register bits associated with each fault condition: fault flag bits, fault bits, and mask bits. The fault flag bits display the real-time fault status. Their status is valid regardless of whether or not that fault is masked. The mask bits either block or allow the fault to affect the fault bit. Each potential fault condition can be masked via I²C if desired. Any unmasked fault condition results in the fault bit going high, which asserts the IRQ pin. IRQ is typically active low. The IRQ pin only de-asserts after the fault condition is no longer present and the corresponding fault bit is read via I²C. Note that masked faults can still be read in the fault flag bit. Refer to Active-Semi Application Note describing the Register Map for full details on I²C functionality and programming ranges.

Output Under/Over Voltage

The ACT8870 monitors the output voltages for under voltage and over voltage conditions. If one output enters an UV/OV fault condition, the IC shuts down all outputs for 100ms and restarts with the programmed power up sequence. If an output is in current limit, it is possible that its voltage can drop below the UV threshold which also shuts down all outputs. If that behavior is not desired, mask the appropriate fault bit. Each output still provides its real-time UV/OV fault status via its fault flag, even if the fault is masked. Masking an OV/UV fault just prevents the fault from being reported via the IRQ pin. A UV/OV fault condition pulls the nRESETx pins low. Note that nRESETx pins are configurable via CMI settings.

Output Current Limit

The ACT8870 incorporates a three level overcurrent protection scheme for the buck converters and a single level scheme for the LDOs. For the buck converters, the overcurrent current threshold refers to the peak switch current. The first protection level is when a buck converter's peak switch current reaches 80% of the Cycle-by-Cycle current limit threshold for greater than 16 switching cycles. Under this condition, the IC reports the fault via the appropriate fault flag bit. If the fault is unmasked, it asserts the IRQ pin. This may or may not turn off that output or other outputs depending on the specific CMI. The next level is when the current increases to the Cycle-by-Cycle threshold. The buck converter limits the peak switch current in each switching cycle. This reduces the effective duty cycle

and causes the output voltage to drop, potentially creating an undervoltage condition. When the overcurrent condition results in an UV condition, and UV is not masked, the IC turns off all supplies off for 100ms and restarts. The third level is when the peak switch current reaches 120% of the Cycle-by-Cycle current limit threshold. This immediately shuts down the regulator and waits 14ms before restarting.

For LDOs, the overcurrent thresholds are set by each LDO's Output Current Limit setting. When the output current reaches the Current Limit threshold, the LDO limits the output current. This reduces the output voltage, creating an undervoltage condition, causing all supplies to turn off for 100ms before restarting.

The overcurrent fault limits for each output are adjustable via I²C. Overcurrent fault reporting can be masked via I²C, but the overcurrent limits are always active and will shut down the IC when exceeded.

Thermal Warning and Thermal Shutdown

The ACT8870 monitors its internal die temperature and reports a warning via IRQ when the temperature rises above the Thermal Interrupt Threshold of typically 135 deg C. It reports a fault when the temperature rises above the Thermal Shutdown Temperature of typically 165 deg C. A temperature fault shuts down all outputs unless the fault is masked. Both the fault and the warning can be masked via I²C. The temperature warning and fault flags still provide real-time status even if the faults are masked. Masking just prevents the faults from being reported via the IRQ pin.

Pin Descriptions

The ACT8870 input and output pins are configurable via CMI configurations. The following descriptions are refer to the most common pin functions. Refer to the CMI Options section in the back of the datasheet for specific pin functionality for each CMI.

PWREN

The PWREN pin controls the IC's SLEEP state. When I²C bit PWREN_MODE = 0, the PWREN pin moves the IC between the SLEEP and ACTIVE states.

PWREN must be enabled via the PWRDN_EN I²C bit after power up. PWREN is ignored if the PWRDN_EN bit is low. The PWREN polarity is controlled by the PWREN_POL I²C bit. PWREN is active low when PWREN_POL is high, and active high when PWREN_POL is low. The host processor can read the PWREN status via I²C in the PWREN_STAT I²C bit.

PWREN is referenced to the VIO_IN pin, and is 5.5V tolerant meaning that PWREN can go to 5.5V even if VIO_IN is less than 5.5V. PWREN has a 10us bidirectional filter to prevent noise from triggering

unwanted operation.

EXT_PG

The EXT_PG pin is a dual purpose input. It functions as either a power good input from an external supply or a dynamic scaling control input. Configure EXT_PG as a power good input by setting I²C bit DVS_EN = 0. When configured as a power good input, EXT_PG can be used as an input to the nRESETx pins. EXT_PG polarity is controlled by the EXT_PG_POL bit. EXT_PG is active high when EXT_PG_POL = 0 and active low when EXT_PG_POL = 1.

Configure EXT_PG as a dynamic voltage scaling (DVS) control input by setting I²C bit DVS_EN = 1. When EXT_PG is de-asserted, all buck regulators regulate to their VSET0 voltage. When EXT_PG is asserted, the buck regulators regulate to their VSET1 voltage. Note that EXT_PG input is only valid for DVS toggling when the IC is in the ACTIVE state of operation. I²C bit EXT_PG_POL has no effect in DVS Mode.

EXT_PG is referenced to the VIO_IN pin, and is 5.5V tolerant meaning that EXT_PG can go to 5.5V even if VIO_IN is less than 5.5V. The EXT_PG input has a 10us bidirectional filter to prevent noise from triggering unwanted operation.

VIO_IN

VIO_IN is the input bias supply for the IC. Apply an input voltage between 1.62V and 5.5V. Bypass to AGND with a high quality, 1uF ceramic capacitor.

MODE

Setting MODE = 0 configures Buck1 as a standard integrated buck regulator. Setting MODE = 1 configures Buck1 as an integrated bypass switch. In bypass mode, the Buck1 P-ch power FET is used to sequence the 3.3V supply to the downstream load. This provides full sequencing flexibility for 3.3V systems by allowing the 3.3V input to be used as the input supply for the other regulators but still be sequenced in any order for the downstream loads. Bypass mode is only valid for a 3.3V input voltage. The MODE pin must be tied directly to VIN or AGND. MODE is only sampled when VIN reaches its UVLO threshold during power. Changing MODE after power up has no effect on functionality. I²C bit MODE_STAT shows the status of the MODE pin when it was read at startup.

GPIO

The GPIO pin can be configured as a digital input or an open drain output. It has multiple uses, including a sequencing input, sequencing output, status output, or control input to toggle a supply's output voltage. Set I²C bit GPIO_OUT = 0 to configure GPIO as an input. When using GPIO as an output, GPIO_OUT = 0 configures it as an open drain output, and GPIO_OUT = 1 configures

it as a logic low output. When used as either an input or an output, I²C bit GPIO_STAT always provides the real-time status of the GPIO pin. GPIO_STAT = 0 when GPIO pin is a logic 0. GPIO_STAT = 1 when GPIO pin is a logic 1.

IRQ

The IRQ pin is an output that issues an interrupt to the host CPU/Controller when an ACT8870 fault or warning condition occurs.

IRQ is triggered by:

1. Die temperature exceeding Thermal Interrupt Threshold of 135C.
2. Any buck regulator reaching peak current limit, ILIMSET, for 16 cycles after softstart.
3. Any LDO regulator reaching current limit, LDOx_ILIM, for more than 16us after softstart.
4. BUCK1 PMOS switch exceeding Current Detection threshold 75% of ILIMSET when system is configured in bypass mode.

IRQ is masked by the I²C register 0x00h bit2 (IRQ_nMASK) by default to mask all IRQ conditions. To enable IRQ functionality, set IRQ_nMASK = 1. IRQ is an active-low open drain 5.5V compatible output.

POK

POK indicates that the voltage on the VIN pin is inside the POK UV and OV Interrupt Thresholds. If the VIN voltage is above or below these values, POK pulls low to interrupt the host CPU/Controller. POK is masked by the I²C bit POK_nMASK by default. To enable POK functionality, set I²C bit POK_nMASK = 1. I²C bits POK_OV and POK_UV provide real-time UV and OV status, even when POK is masked. The POK UV and OV threshold are configurable via the I²C bits POK_UV_SET and POK_OV_SET.

POK is an open drain output and is 5.5V tolerant meaning that POK can be pulled up to 5.5V even if VIO_IN is less than 5.5V.

nRESET_AUX1 and nRESET_AUX2

nRESET_AUX1 and nRESET_AUX2 pins can be used to signal that the IC is in the SLEEP state or that the input voltage is above or below the UV or OV threshold. They can also be tied to one or a combination of the power supply's internal POK signal. These outputs are immediately asserted low, but follow a programmed delay when de-asserted. The nRESET_AUX1 delay time is controlled by the I²C bits RST_AUX1_DLY[2:0], which programs the delay between 400us and 2mS in 227us steps. The nRESET_AUX2 delay time is

controlled by the I²C bits RST_AUX2_DLY[2:0], which programs the delay between 200us and 1ms in 114us steps. These pins are open drain output and 5.5V tolerant meaning that they can be pulled up to 5.5V even if VIO_IN is less than 5.5V.

nRESET

nRESET issues the main reset to the CPU/controller. nRESET is immediately asserted low when either the VIN voltage is above or below the UV or OV thresholds or any valid output supply voltage is below its Power Good threshold. After startup, nRESET de-asserts after a programmable delay time when VIN and all outputs are above their respective UVLO thresholds. The nRESET delay time is controlled by the I²C bits nRST_DLY[2:0], which programs the delay between 200us and 1ms in 114us steps. nRESET is configurable, so refer to the CMI Options section in the back of the datasheet for its specific functionality for each CMI. nRESET is an open drain output and is 5.5V tolerant meaning that nRESET can be pulled up to 5.5V even if VIO_IN is less than 5.5V.

EXT_EN

EXT_EN is used to control an external regulator or to provide a control signal to other system components. Depending on the MODE pin status, EXT_EN is either an exact output of the ACT8870's internal BUCK1 enable signal or an exact output of the bypass switch enable signal. The I²C bit EXT_EN_POL controls the EXT_EN polarity. EXT_EN is active high when EXT_EN_POL is low and EXT_EN is active low when EXT_EN_POL is high. EXT_EN is a push-pull CMOS output using VIO_IN supply. Note that the EXT_EN output is enabled and valid in all modes of operation. EXT_EN is configurable, so refer to the CMI Options section in the back of the datasheet for its specific functionality for each CMI.

PG signals the status of a regulator's Power Good / UV comparator. When the regulator is below the Power Good threshold, the PG pin is pulled low. When above the threshold, the PG pin is open drain. The PG functionality is enabled by default, but can be disabled by I²C. Disable PG for each regulator using the regulator's UV_FLTMSK bit. PG is configurable, so refer to the back of the datasheet for its specific functionality for each CMI. PG is an open drain output and is 5V tolerant meaning that PG can be pulled up to 5.5V even if VIO_IN is less than 5.5V.

Step-down dc/dc Converters

General Description

The ACT8870 contains four fully integrated step-down converters. Buck1 is a 4A output, while Buck2, Buck3, and Buck4 are 2.5A outputs. All buck converters are fixed frequency, current-mode controlled, synchronous

PWM converters that achieve peak efficiencies of up to 96.5%. The buck converters switch at 2.25MHz and are internally compensated, requiring only three small external components (Cin, Cout, and L) for operation. They ship with default output voltages that can be modified via the I²C interface for systems that require advanced power management functions.

Each buck converter has a dedicated input pin and power ground pin. Each buck converter should have a dedicated input capacitor that is optimally placed to minimize the power routing loops for each buck converter. Note that even though each buck converter has separate inputs, all buck converter inputs must be connected to the same voltage potential.

Buck 1 is configurable as a bypass switch for systems with a 3.3V bus voltage. The bypass switch provides full sequencing capability by allowing the 3.3V bus to be used as the input to the other supplies and still be properly sequenced to the downstream load.

Tie MODE to AGND to configure Buck1 for a switching power supply. Tie MODE to VIN to configure Buck1 as a bypass switch. MODE is only sampled when VIN reaches its UVLO threshold. Changing the MODE pin after startup has no effect. When Buck1 is configured as a power supply, EXT_EN is a direct output of the ACT8870 Buck1 enable signal. When Buck1 is configured as a bypass switch, EXT_EN is a direct output of the bypass switch enable signal.

The ACT8870 buck regulators are highly configurable and can be quickly and easily reconfigured via I²C. This allows them to support changes in hardware requirements without the need for PCB changes. Examples of I²C functionality are given below:

Real-time power good, OV, and current limit status

Ability to mask individual faults

Dynamically change output voltage

On/Off control

Softstart ramp

Slew rate control

Switching delay and phase control

Low power mode

Overcurrent thresholds

Refer to the Active-Semi Application Note describing the Register Map for full details on I²C functionality and programming ranges.

Operating Mode

The buck converters operate in fixed-frequency PWM mode at medium to heavy loads. They transition to a proprietary power-saving low power mode (LPM) at light loads in order to save power. Each buck converter's LPM can be independently enabled or disabled via its DISLPM I²C bit. Setting DISLPM = 0 enables LPM while setting DISLPM = 1 disables LPM. Operating in LPM saves power, while operating in forced PWM mode gives better transient response. Each buck converter output can be programmed between 2.8V and 5.5V with the I²C register Bx_VSEL0[7:0].

Enable / Disable Control

When power is applied to the IC, all converters automatically turn on according to a pre-programmed sequence. Once in normal operation (ACTIVE state), each converter can be independently disabled via I²C. Each CMI version requires a different set of command to disable a converter, so contact the factory for specific instructions if needed. Each converter contains an optional integrated discharge resistor that actively discharges the output capacitor when the regulator is disabled. The discharge function is enabled via the I²C bit Bx_DisPull-down.

Soft-Start

Each buck regulator contains a softstart circuit that limits the rate of change of the output voltage, minimizing input inrush current and ensuring that the outputs power up monotonically. This circuitry is effective any time the regulator is enabled, as well as after responding to a short circuit or other fault condition. Each regulator's softstart time is adjustable between 300us and 1000us via its I²C bits SS_RAMP.

100% Duty Cycle Operation

The buck regulators are capable of operating at up to 100% duty cycle. During 100% duty cycle operation, the high-side power MOSFETs are held on continuously, providing a direct connection from the input to the output (through the inductor), ensuring the lowest possible dropout voltage in battery powered applications.

Dynamic Voltage Scaling

Each buck converter supports Dynamic Voltage Scaling (DVS). DVS allows the user to optimize the processor's energy to complete tasks by lowering the processor's operating frequency and input voltage when lower performance is acceptable. In normal operation, each output regulates to the voltage programmed in the I²C register Bx_VSET0. During DVS, each output regulates to Bx_VSET1. The output transitions from Bx_VSET0 to Bx_VSET1 at a rate determined by the output capacitance and the load current. The outputs transition between VSET1 and VSET0 by the rate determined by the I²C bits SLEW.

For fault free operation, the user must ensure output load conditions plus the current required to charge the output capacitance during a DVS rising voltage condition does not exceed the current limit setting of the regulator. As with any power supply, changing an output voltage too fast can require a current higher than the current limit setting. The user must ensure that the voltage step, slew rate, and load current conditions do not result in an instantaneous loading that results in a current limit condition.

Enter DVS by programming register 0x00h bit1 (DVS_EN) = 1 and then pulling the EXT_EN pin high. Note that some CMI configurations may not require DVS_EN = 1 and may use different input pins.

Bx_VSET0 must be higher than Bx_VSET1. PWR_GOOD, OV, and ILIM are automatically masked during DVS transitions to avoid asserting nRESET.

Optimizing Noise

Each buck converter contains several features available via I²C to further optimize functionality. The top P-ch FET's turn-on timing can be shifted 100ns from the master clock edge via the PHASE_DELAY I²C bit. It can also be aligned to the rising or falling clock edge via the PHASE I²C bit. The internal FET rise and fall times can be optimized to minimize switching noise at the cost of lower efficiency via the DRVADJ I²C bit.

Overcurrent and Short Circuit Protection

Each buck converter provides overcurrent and short circuit protection. Overcurrent protection is achieved with cycle-by-cycle current limiting. The peak current threshold is set by the Bx_ILIM I²C bits. If the peak current reaches the programmed threshold for 16 consecutive switching cycles, the IC asserts IRQ low. A short circuit condition that results in the peak switch current being 122% of Bx_ILIMSET immediately shuts down all supplies, asserts IRQ low and restarts the system in 100ms. If a buck converter reaches overcurrent or short circuit protection, the status is reported in the ILIM_REG[x] I²C registers. The contents of these registers are latched until read via I²C. Overcurrent and short circuit conditions can be masked via the I²C bit Bx_ILIM_FLTMSK.

Compensation

The buck converters utilize current-mode control and a proprietary internal compensation scheme to simultaneously simplify external component selection and optimize transient performance over their full operating range. No compensation design is required; simply follow a few simple guide lines described below when choosing external components.

Minimum On-Time

The ACT8870 minimum on-time is 120ns. If the calcu-

lated on-time is less than 120ns with 2.25MHz operation, then the user must configure the output to switch at 1.125MHz. Setting I²C bits Bx_HalfFreq = 0 sets Fsw = 2.25MHz. Setting Bx_HalfFreq = 1 sets Fsw = 1.125MHz. The following equation calculates the on-time.

$$T_{ON} = \frac{V_{OUT}}{V_{IN} * F_{SW}}$$

Where V_{out} is the output voltage, V_{in} is the input voltage, and F_{sw} is the switching frequency.

BUCK1 Bypass Switch

The ACT8870 provides a bypass mode for 3.3V systems. This allows the 3.3V input voltage to power the ACT8870 regulators and also be sequenced to the downstream loads. In bypass mode, the Buck1 P-ch FET acts as a switch and the N-ch FET is disabled. The bypass switch turns on the 3.3V rail with the programmed delay and softstart time.

In bypass mode, the ACT8870 I²C registers are reconfigured to the following.

1. B1_PWR_GOOD register bit reconfigured to the output of the Soft Start ramp. When soft start is complete, this bit goes high to allow the sequencing of the other regulators to continue. B1_PWR_GOOD no longer reports the Buck1 output voltage status. It stays high as long as the bypass switch is enabled.
2. B1_ILIM bit is the output of the internal PMOS Current Detection circuit. This is set to 3A typical. If the bypass current exceeds the Internal PMOS Current Detection current, B1_ILIM triggers an IRQ output and gets latched in the ILIM_REG[0] if configured by the IRQ_nMASK. The B1_ILIM can also be masked with the B1_ILIM_FLTMSK register.
3. B1_UV register bit reconfigured to the output of the Internal PMOS Current Shutdown circuit. This is set to 6A typical. If the bypass switch current exceeds 6A, limits the current which triggers an under voltage fault condition and moves the IC into the OVUVFLT state. This immediately shuts down all regulators including the bypass switch. The system restarts in 100mS, following the programmed startup sequencing. This fault can be masked with I²C bit UV_nMASK. This fault is latched in the UV_REG I²C bit. Shutdown due to overcurrent can also be masked via the I²C bit B1_PG_FLTMSK.
4. B1_OV is disabled. There is no overvoltage detection circuitry on the output of the bypass switch.

Input Capacitor Selection

Each regulator requires a high quality, low-ESR, ceramic input capacitor. Note that even though each buck converter has separate input pins, all input pins must be connected to the same voltage potential. 10uF capacitors are typically suitable, but this value can be increased without limit. Smaller capacitor values can be used with lighter output loads. Choose the input capacitor value to keep the input voltage ripple less than 50mV.

$$V_{\text{ripple}} = I_{\text{out}} * \frac{V_{\text{out}}}{V_{\text{in}}} * \left(1 - \frac{V_{\text{out}}}{V_{\text{in}}}\right) \frac{1}{F_{\text{sw}} * C_{\text{in}}}$$

Be sure to consider the capacitor's DC bias effects and maximum ripple current rating when using capacitors smaller than 0805.

A capacitor's actual capacitance is strongly affected by its DC bias characteristics. The input capacitor is typically an X5R, X7R, or similar dielectric. Use of Y5U, Z5U, or similar dielectrics is not recommended. Input capacitor placement is critical for proper operation. Each buck's input capacitor must be placed as close to the IC as possible. The traces from VIN_Bx to the capacitor and from the capacitor to PGNDx should as short and wide as possible.

Inductor Selection

The Buck converters utilize current-mode control and a proprietary internal compensation scheme to simultaneously simplify external component selection and optimize transient performance over their full operating range. The ACT8870 is optimized for operation with 1.0-1.5uH inductors. Choose an inductor with a low DC-resistance, and avoid inductor saturation by choosing inductors with DC ratings that exceed the maximum output current by at least 30%. The following equation calculates the inductor ripple current.

$$\Delta I_L = \frac{\left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}\right) * V_{\text{OUT}}}{F_{\text{SW}} * L}$$

Where V_{OUT} is the output voltage, V_{IN} is the input voltage, F_{SW} is the switching frequency, and L is the inductor value.

Output Capacitor Selection

The ACT8870 is designed to use small, low ESR, ceramic output capacitors. Buck1 typically requires a 44uF output capacitor while Buck2, Buck3, and Buck4 require a 22uF output capacitor each. In order to ensure stability, the actual Buck1 capacitance should be greater than 33uF while Buck2, Buck3, and Buck4 should be greater than 15uF. The output capacitance can be increased to reduce output voltage ripple and

improve load transients if needed. Design for an output ripple voltage less than 1% of the output voltage. The following equation calculates the output voltage ripple as a function of output capacitance.

$$V_{\text{RIPPLE}} = \frac{\Delta I_L}{8 * F_{\text{SW}} * C_{\text{OUT}}}$$

Where ΔI_L is the inductor ripple current, F_{SW} is the switching frequency, and C_{OUT} is the output capacitance after taking DC bias into account.

Be sure to consider the capacitor's DC bias effects and maximum ripple current rating when using capacitors smaller than 0805.

A capacitor's actual capacitance is strongly affected by its DC bias characteristics. The output capacitor is typically an X5R, X7R, or similar dielectric. Use of Y5U, Z5U, or similar dielectrics are not recommended due to their wide variation in capacitance over temperature and voltage ranges.

LDO CONVERTERS

General Description

The ACT8870 contains three fully integrated low dropout linear regulators (LDO). LDO1 is an 800mA output, while LDO2 and LDO3 are 200mA outputs. The LDOs are require only two small external components (C_{in}, C_{out}) for operation. They ship with default output voltages that can be modified via the I²C interface for systems that require advanced power management functions.

LDO1 has a dedicated input pin. LDO2 and LDO3 share an input pin. The LDOs can operate from different input voltages than the buck converters. LDO1 and LDO2/3 can operate from different input voltage from each other.

Enable / Disable Control

When power is applied to the IC, all LDOs automatically turn on according to a pre-programmed sequence. Once in normal operation (ACTIVE state), each converter can be independently disabled via I²C. Each CMI version requires a different set of command to disable a converter, so contact the factory for specific instructions if needed. Each converter contains an optional integrated discharge resistor that actively discharges the output capacitor when the regulator is disabled. Each LDO's discharge function is enabled via its I²C bit DIS_PULLDOWN.

Soft-Start

Each LDO contains a softstart circuit that limits the rate of change of the output voltage, minimizing input inrush current and ensuring that the outputs power up in a monotonically. This circuitry is effective any time the

LDO is enabled, as well as after responding to a short circuit or other fault condition. Each LDO's softstart time is adjustable via its I²C bits SS_RAMP. LDO1 is adjustable between 240μs and 660μs, depending on output voltage. LDO2 and LDO3 are adjustable between 110μs and 235μs, depending on output voltage. See the EC table for available programming ranges.

Overcurrent and Short Circuit Protection

Each LDO provides overcurrent and short circuit protection. The overcurrent threshold is set by the LDOx_ILIM I²C bits. In both an overload and a short circuit condition, the LDO limits the output current which causes the output voltage to drop. This can result in an undervoltage fault in addition to the current limit fault. If an LDO reaches current limit protection, the status is reported in the ILIM_REG[x] I²C registers. The contents of these registers are latched until read via I²C. When the current limiting results in a drop in output voltage that triggers an undervoltage condition, the IC shuts down all power supplies, asserts IRQ low, and enters the UVLOFLT state. The IC restarts in 100ms and starts up with default sequencing. Overcurrent and short circuit conditions can be masked via the I²C bit LDOx_ILIM_FLTMSK.

Input Capacitor Selection

Each LDO requires a high quality, low-ESR, ceramic input capacitor. A 1μF is typically suitable, but this value can be increased without limit. The input capacitor is should be a X5R, X7R, or similar dielectric.

Output Capacitor Selection

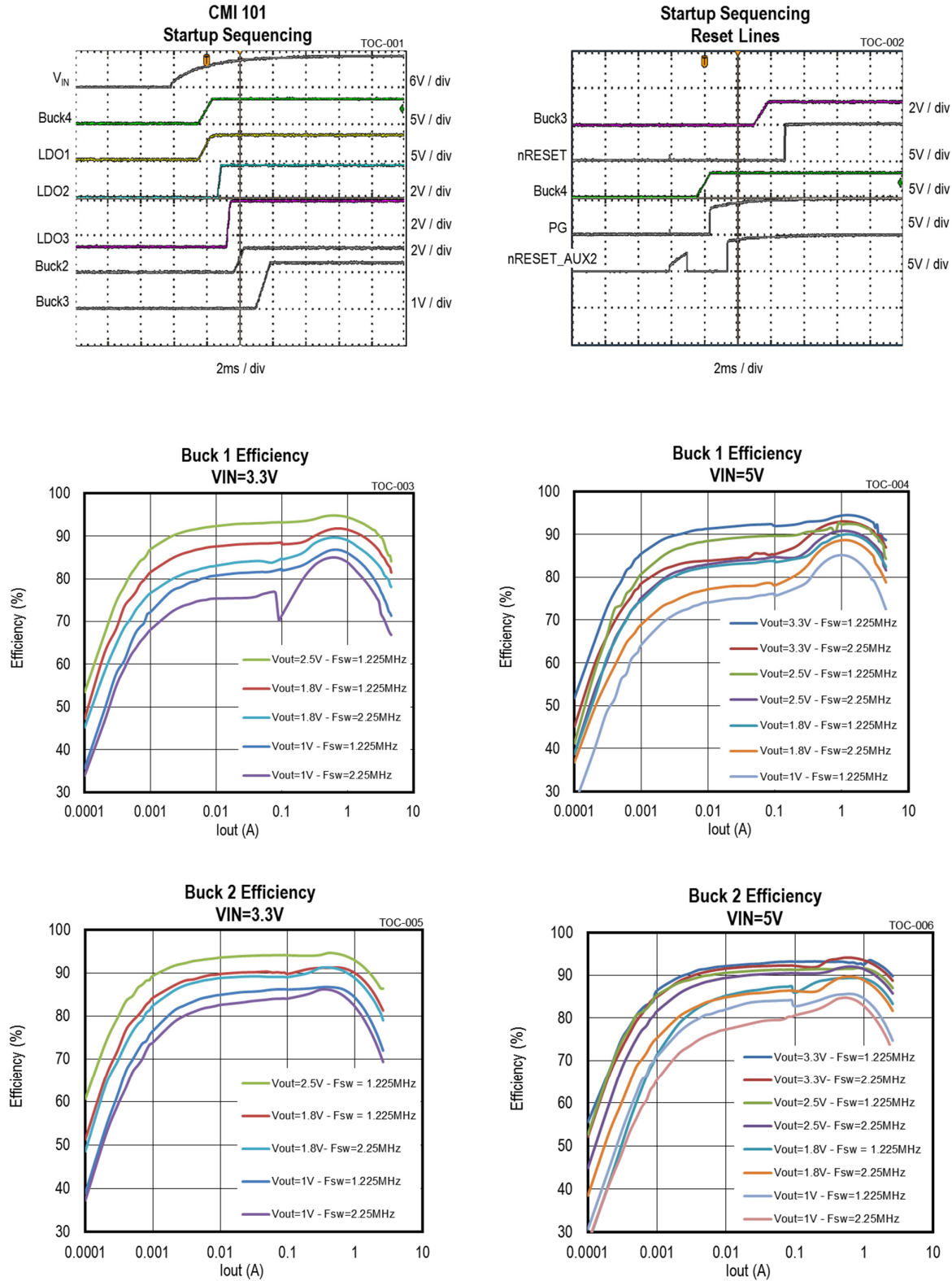
Each LDO requires a high quality, low-ESR, ceramic output capacitor. A 1μF is typically suitable, but this value can be increased without limit. The input capacitor is should be a X5R, X7R, or similar dielectric.

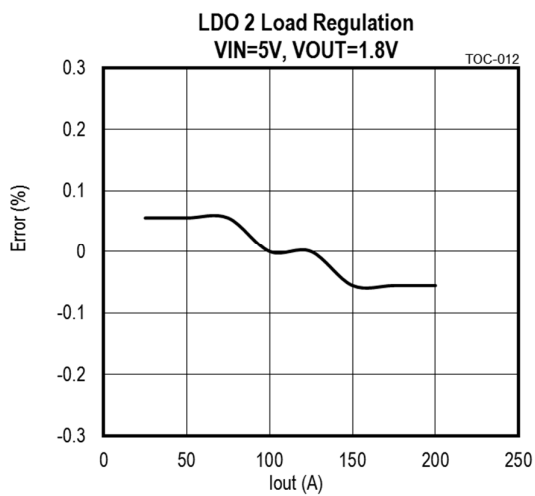
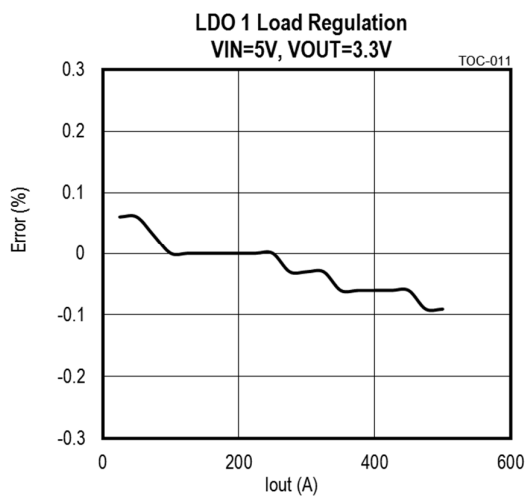
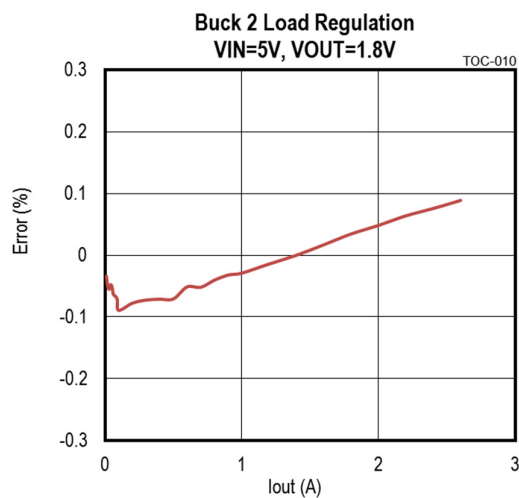
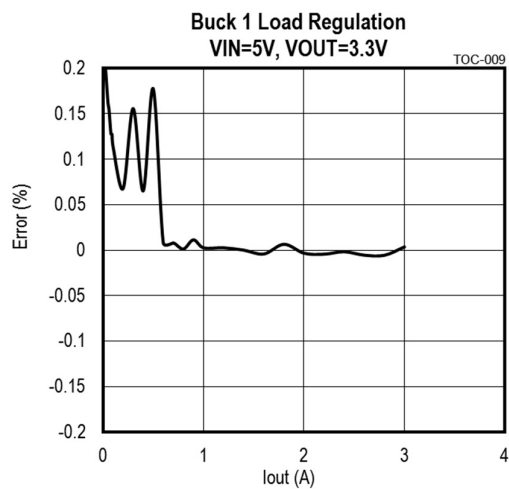
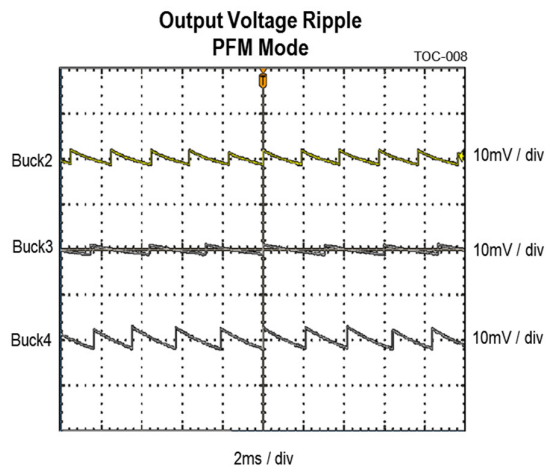
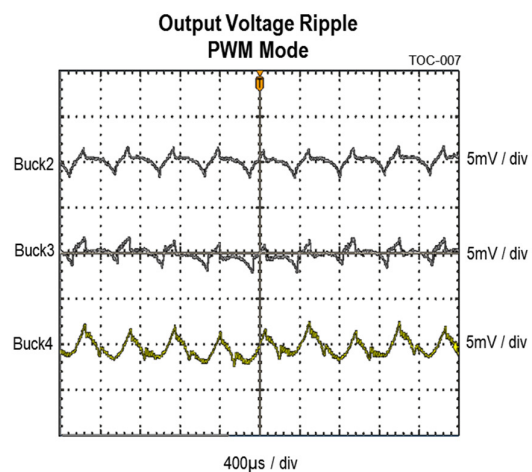
PC board layout guidance

Proper parts placement and PCB layout are critical to the operation of switching power supplies. Follow the following layout guidelines when designing the ACT8870 PCB. Refer to the Active-Semi ACT8870 Evaluation Kits for layout examples

1. Place the buck input capacitors as close as possible to the IC. Connect the capacitors directly to the corresponding VIN_Bx input pin and PGNDx power ground pin. Avoid the use of vias if possible.
2. Minimize the switch node trace length between each SW_Bx pin and the inductor. Avoid routing sensitive analog signals near these high frequency, high dV/dt traces.
3. Place the LDO input capacitors close to their input pins. Connect their ground pins into the ground plane that connects the IC's exposed pad.
4. The input capacitor and output capacitor grounds should be connected as close together as possible, with short, direct, and wide traces.
5. Connect the PGNDx ground pins and the AGND ground pin directly to the exposed pad under the IC. The AGND ground plane should be routed separately from the other ground planes and only connect to the main ground plane under the IC at the AGND pin.
6. Connect the VIO_IN input capacitor to the AGND ground pin.
7. Connect the VIN input capacitor to the AGND ground pin.
8. Remember that all open drain outputs need pullup resistors.
9. Connect the exposed pad directly the top layer ground plane. Connect the top layer ground plane to both internal ground planes and the PCB backside ground plane with thermal vias. Provide ground plane routing on multiple layers that allows the IC's heat to flow into the PCB and then spread radially from the IC. Avoid cutting the ground planes and adding vias that restrict the radial flow of heat of operating conditions, and are relatively insensitive to layout considerations.

Typical Operating Characteristics

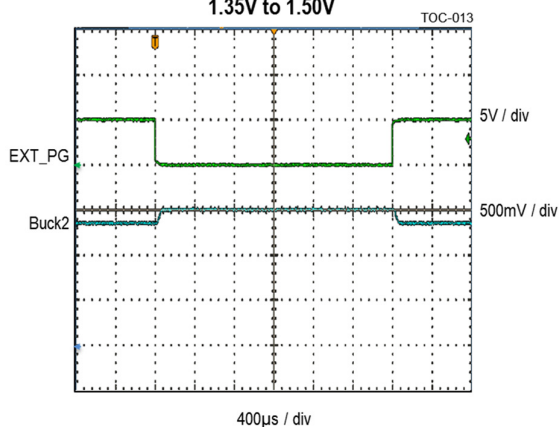




DVS Transition

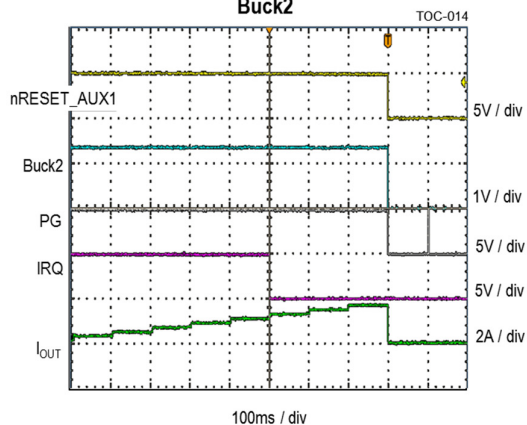
Buck2

1.35V to 1.50V



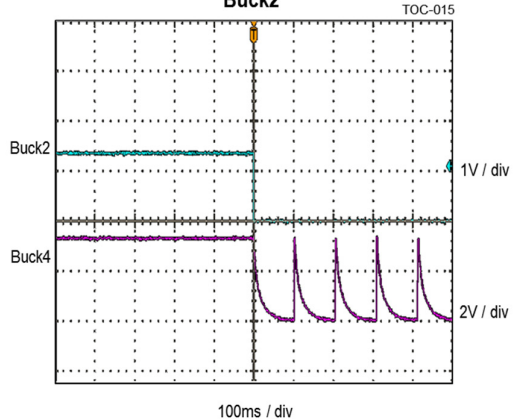
Overcurrent

Buck2



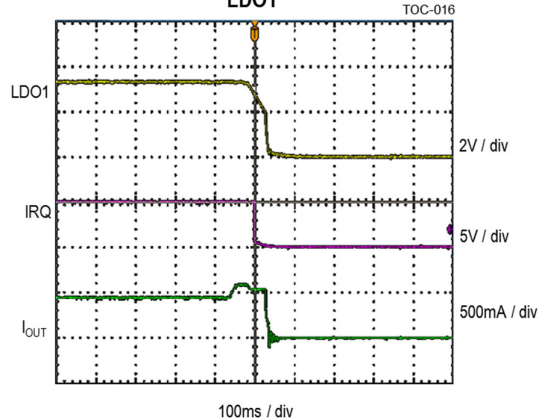
Short Circuit

Buck2



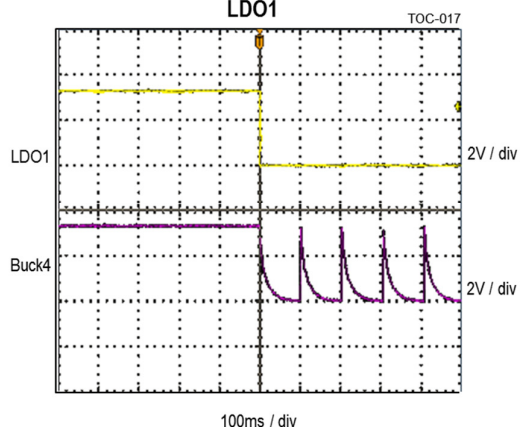
Overcurrent

LDO1

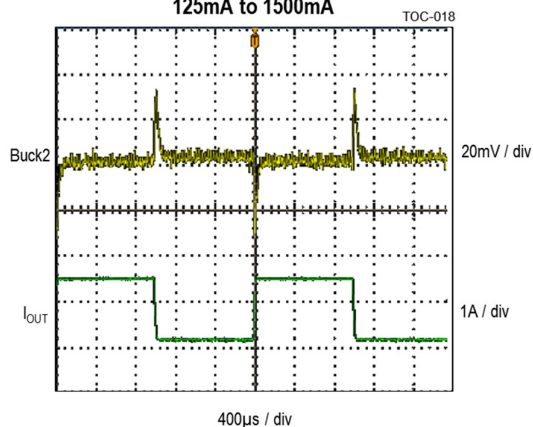


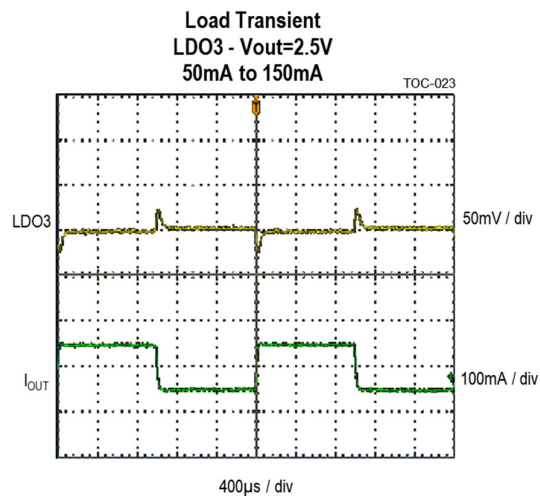
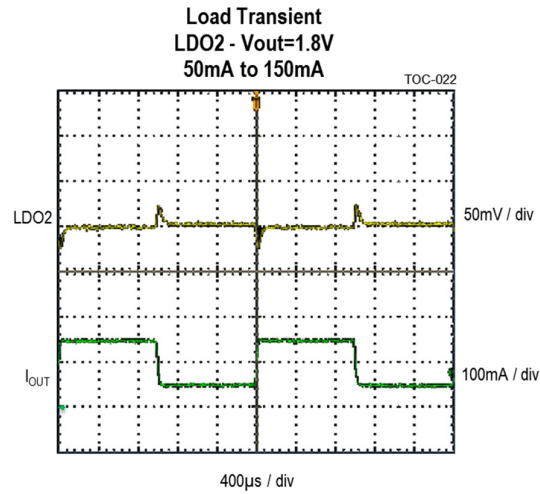
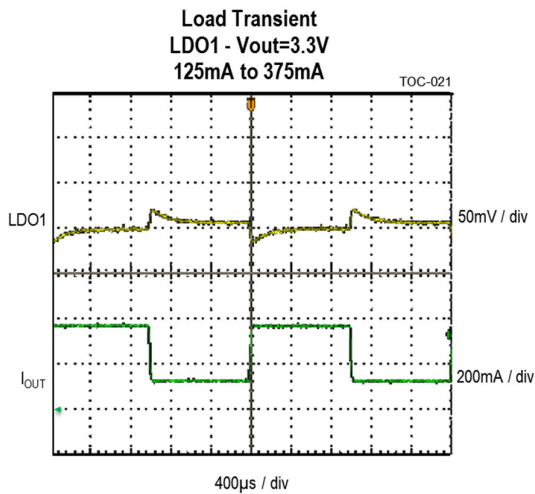
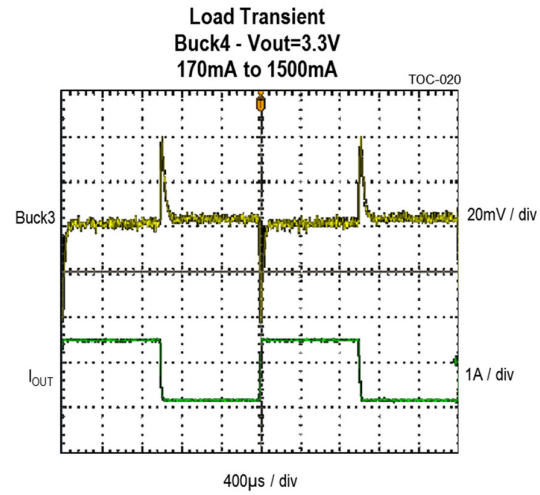
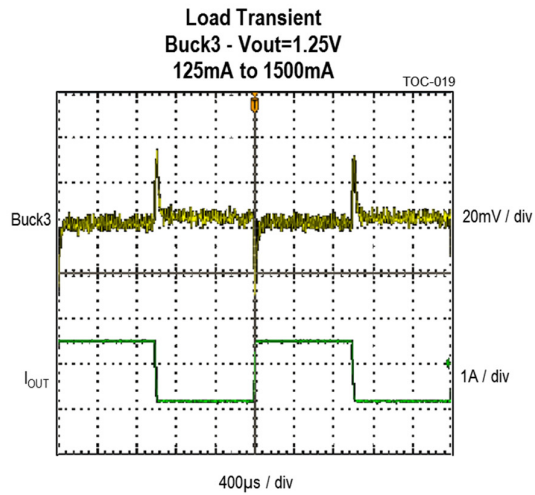
Short Circuit

LDO1



Load Transient
Buck2 - Vout=1.5V
125mA to 1500mA





Recommended External Components

The following components have been used with the ACT8870.

REFERENCE	DESCRIPTION	MANUFACTURER
Input Capacitor, Buck1	22uF, 6.3V, X5R	Samsung, CL10A226MQ8NRNC
Input Capacitor, Buck2/3/4	10uF, 10V, X5R	Samsung, CL10A106KP8NNNC
Input Capacitor, LDO1/2/3	1uF, 25V, X7R	Yageo, CC0603KRX7R8BB105
Output Capacitor, Buck1	2x22uF, 6.3V, X5R	Samsung, CL10A226MQ8NRNC
Output Capacitor, Buck2/3/4	22uF, 6.3V, X5R	Samsung, CL10A226MQ8NRNC
Output Capacitor, LDO1/2/3	1uF, 25V, X7R	Yageo, CC0603KRX7R8BB105
Inductor, Buck1	1uH, 10.8mohm	Coilcraft, XFL4020-102
Inductor, Buck2/3/4	1uH, 15mohm	Würth, 74438356010
VIO_IN	100nF, 6.3V, X5R	Standard
VIN	1uF, 6.3V, X5R	Standard

CMI OPTIONS

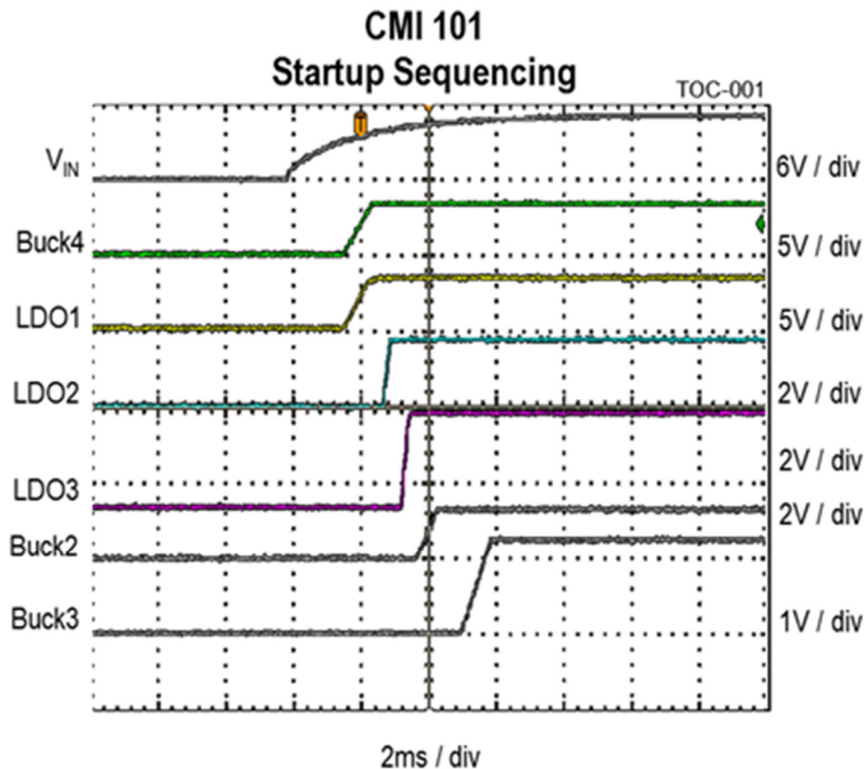
This section provides the basic default configuration settings for each available ACT8870 CMI option. Refer to each option's application note for the comprehensive list of default settings

CMI 101: ACT8870QJ101-T

CMI 101 is optimized for Atmel SAMA5D2. Buck1 is not used in this application. Buck4 and LDO1 power the SAMA5D2 Group 2 power supply inputs. Buck2 and Buck3 power the Group 1 power supply inputs. LDO3 powers VDDFUSE which is not part of Group 1 or Group 2. LDO2 provides 1.8V power for other parts of the system.

Sequencing

Rail	Active Mode Voltage (V)	Sleep Mode Voltage (V)	DVS Voltage (V)	DVS slew rate (mV/us)	Nominal Current (A)	Current Limit Setting(A)	Sequencing Input Trigger	StartUp Delay (us)	Soft-Start (us)
Buck 1	OFF	N/A	OFF	N/A	N/A	N/A	N/A		
Buck 4	3.3	N/A	3.3	3.12	0.1	2	VIN_UVLO	300	700
LDO1	3.3	N/A	3.3	NA	0.4	0.5	VIN_UVLO	100	613
LDO2	1.8	N/A	1.8	NA	0.05	0.2	BUCK4_PG	300	150
LDO3	2.5	N/A	2.5	NA	0.05	0.2	LDO2_PG	300	150
Buck 2	1.5	N/A	1.35	3.12	0.1	2	LDO3_PG	200	500
Buck 3	1.25	N/A	1.25	3.12	0.1	2	BUCK2_PG	700	700



SLEEP Mode

SLEEP Mode is not available in CMI 101. Connect PWREN to AGND

DVS Mode

DVS mode does not require changing I²C bit DVS_EN. The IC can enter DVS mode regardless of the DVS_EN setting. Drive EXT_PG to a logic L for normal operation. Drive EXT_PG to a logic H for DVS mode. Note that Buck3/4 cannot enter DVS mode with this CMI code. Their VSET1 setting is not used.

POK Thresholds

POK_UV = 2.8V

POK_OV = 5.5V

PG

The PG pin is asserted high when Buck4 is in regulation.

I²C Address

The CMI 101 7-bit I²C address is 0x5Ah. This results in 0xB4h for a write address and 0xB5h for a read address.

Device ID

The CMI 101 Device ID (register 0x7Dh) = 0x2Fh

nRESET

nRESET is asserted low when any output is out of regulation. The reset timing is 996us

nRESET_AUX1

nRESET_AUX1 is asserted low when Buck2 is out of regulation. The reset timing is 1764us

nRESET_AUX2

nRESET_AUX2 is asserted low when Buck4 is out of regulation. The reset timing is 996us

Default Mask Settings

CMI 101 Default Mask Settings								
nRESET	nRESET_AUX1	nRESET_AUX2	VIN_OV	IRQ	POK	Thermal Shutdown	UV	OV
Masked	Masked	Masked	Unmasked	Masked	Masked	Unmasked	Unmasked	Unmasked

CMI 102: ACT8870QJ102-T

CMI 102 is optimized for Silicon Motion SM2258 and SM2259 solid state disk drive controllers. It incorporates boot voltage options for Buck2 and Buck3 that allow it to be used with 1.5V or 1.35V DRAM VDDQ and with 1.2V or 1.8V NAND flash I/O.

SM225x Configuration

The following table shows how to connect the ACT8870 outputs to the SM225x. The EXT_PG and nRESET_AUX2 input settings define Buck2 and Buck3 to be 1.5V and 1.2V respectively.

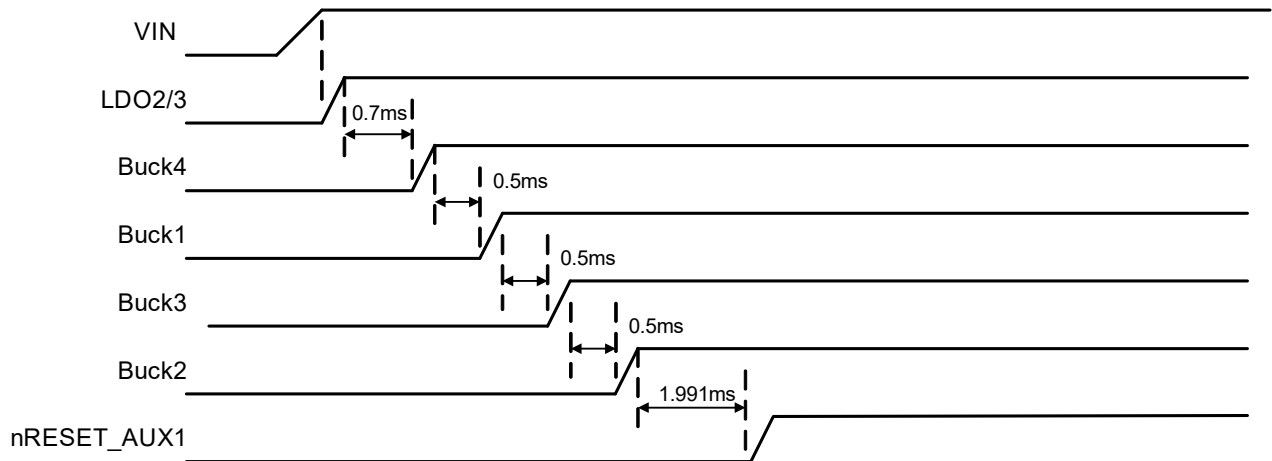
	SM2258 Voltage (V)	SM2259 Voltage (V)	SM225x Connections
EXT_PG Input Setting	n/a	n/a	n/a, EXT_PG sets Buck2 boot voltage
nRESET_AUX2 Input Setting	n/a	n/a	n/a, nRESET_AUX2 sets Buck3 boot voltage
Buck1	3.3	3.3	VCCF for Flash Die Power
Buck2	1.5/1.35	1.5/1.35	DRAM – DDR3
Buck3	1.2/1.8	1.2/1.8	VCCFQ for Flash I/O
Buck4	1.15	1.15	VCCK/A1V1
LDO1	3.3	3.3	A3V3 Analog Power
LDO2	1.8	1.8	VCCIO Power
LDO3	1.8	1.8	VCCIO Power

Sequencing

Rail	Active Mode Volt- age (V)	Sleep Mode Volt- age (V)	DVS Volt- age (V)	DVS slew rate (mV/us)	Current Limit Setting(A)	Sequencing Input Trigger	StartUp Delay (us)	Soft-Start (us)
LDO1	3.3	3.3	N/A	N/A	0.5	VIN_UVLO	28	660
LDO2	1.8	1.8	N/A	N/A	0.2	VIN_UVLO	28	165
LDO3	1.8	1.8	N/A	N/A	0.2	VIN_UVLO	28	165
Buck4	1.15	0.95	N/A	N/A	3.5	LDO1	700	500
Buck1	3.3	OFF	N/A	N/A	5.3	Buck4	500	500
Buck3	1.2/1.8	OFF	N/A	N/A	3	Buck1	500	500
Buck2	1.5/1.35	OFF	N/A	N/A	3	Buck3	500	500

Startup

CMI 102 Startup



SLEEP Mode

Enter SLEEP Mode by pulling PWREN low. The IC operates in Active mode when PWREN is high. Note that in the default configuration, nRESET_AUX1 goes low when the IC enters Sleep mode. If the user requires nRESET_AUX1 to stay high in Sleep mode, write a 1 into register 0x00h, bit 7.

DVS Mode

CMI 102 does not include the DVS function. Note that the processor can change Buck2 and Buck3 output voltages on the fly with EXT_PG and nRESET_AUX2. This effectively provides independent DVS control for these two outputs.

Buck2 VID Boot Voltage - EXT_PG

The EXT_PG input sets the Buck2 boot up voltage. When EXT_PG = 0, Buck2 = 1.5V. When EXT_PG = 1, Buck2 = 1.35V. EXT_PG changes Buck2 at startup and during normal operation.

Buck3 VID Boot Voltage - nRESET_AUX2

The nRESET_AUX2 input sets the Buck3 boot up voltage. When nRESET_AUX2 = 0, Buck3 = 1.2V. When nRESET_AUX2 = 1, Buck3 = 1.8V. nRESET_AUX2 changes Buck3 at startup and during normal operation.

POK Thresholds

POK_UV = 4.25V

POK_OV = 5.7V

PG

The PG pin is not functional with CMI 102. Leave the PG pin floating.

nRESET

nRESET is not functional in CMI 102. Leave the nRESET pin floating.

nRESET_AUX1

nRESET_AUX1 is asserted low when any regulator is out of regulation. The reset timing is 1991us. Note that in the default configuration, nRESET_AUX1 goes low when the IC enters Sleep mode. If the user requires nRESET_AUX1 to stay high in Sleep mode, write a 1 into register 0x00h, bit 7.

nRESET_AUX2

nRESET_AUX2 is used for Buck3 boot voltage. See above.

MODE

The MODE pin must be tied to ground.

GPIO

The GPIO pin must be tied to ground.

Default Mask Settings

CMI 102 Default Mask Settings								
nRESET	nRESET_AUX1	nRESET_AUX2	VIN_OV	IRQ	POK	Thermal Shutdown	UV	OV
Masked	Masked	Masked	Unmasked	Masked	Masked	Unmasked	Unmasked	Unmasked

Device ID

The CMI 102 Device ID (register 0x7Dh) = 0x0Bh

I2C Address

The CMI 102 7-bit I2C address is 0x5Ah. This results in 0xB4h for a write address and 0xB5h for a read address.

CMI 104: ACT8870QJ104-T

CMI 104 is optimized for Silicon Motion SM2246 solid state disk drive controllers. It incorporates boot voltage options for Buck2 and Buck3 that allow it to be used with 1.5V or 1.35V DRAM VDDQ and with 1.2V or 1.8V NAND flash I/O.

SM2246 Configuration

The following table shows how to connect the ACT8870 outputs to the SM2246. The EXT_PG and nRESET_AUX2 input settings define Buck2 and Buck3 default startup voltages.

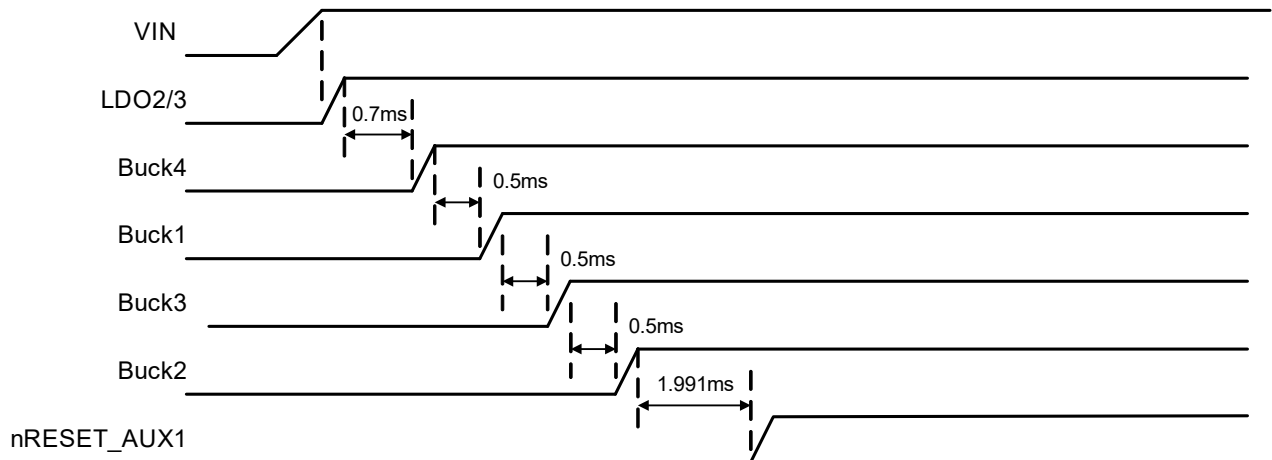
	SM2246 Voltage (V)	SM2246 Connections
EXT_PG Input Setting	n/a	n/a. EXT_PG sets Buck2 boot voltage
nRESET_AUX2 Input Setting	n/a	n/a. nRESET_AUX2 sets Buck3 boot voltage
Buck1	3.3	VCCF for Flash Die Power
Buck2	1.5/1.35	DRAM – DDR3
Buck3	1.2/1.8	VCCFQ for Flash I/O
Buck4	1.2	VCC/A1V1
LDO1	3.3	A3V3 Analog Power
LDO2	1.8	VCCIO Power
LDO3	1.8	VCCIO Power

Sequencing

Rail	Active Mode Volt-age (V)	Sleep Mode Volt-age (V)	DVS Volt-age (V)	DVS slew rate (mV/us)	Current Limit Setting(A)	Sequencing Input Trigger	StartUp Delay (us)	Soft-Start (us)
LDO1	3.3	3.3	N/A	N/A	0.5	VIN_UVLO	28	660
LDO2	1.8	1.8	N/A	N/A	0.2	VIN_UVLO	28	165
LDO3	1.8	1.8	N/A	N/A	0.2	VIN_UVLO	28	165
Buck4	1.2	1	N/A	N/A	3.5	LDO1	700	500
Buck1	3.3	OFF	N/A	N/A	5.3	Buck4	500	500
Buck3	1.2/1.8	OFF	N/A	N/A	3	Buck1	500	500
Buck2	1.5/1.35	OFF	N/A	N/A	3	Buck3	500	500

Startup

CMI 104 Startup



SLEEP Mode

Enter SLEEP Mode by pulling PWREN low. The IC operates in Active mode when PWREN is high. Note that in the default configuration, nRESET_AUX1 goes low when the IC enters Sleep mode. If the user requires nRESET_AUX1 to stay high in Sleep mode, write a 1 into register 0x00h, bit 7.

DVS Mode

CMI 104 does not include the DVS function. Note that the processor can change Buck2 and Buck3 output voltages on the fly with EXT_PG and nRESET_AUX2. This effectively provides independent DVS control for these two outputs.

Buck2 VID Boot Voltage - EXT_PG

The EXT_PG input sets the Buck2 boot up voltage. When EXT_PG = 0, Buck2 = 1.5V. When EXT_PG = 1, Buck2 = 1.35V. EXT_PG changes Buck2 at startup and during normal operation.

Buck3 VID Boot Voltage - nRESET_AUX2

The nRESET_AUX2 input sets the Buck3 boot up voltage. When nRESET_AUX2 = 0, Buck3 = 1.2V. When nRESET_AUX2 = 1, Buck3 = 1.8V. nRESET_AUX2 changes Buck3 at startup and during normal operation.

POK Thresholds

POK_UV = 4.25V

POK_OV = 5.7V

PG

The PG pin is not functional with CMI 104. Leave the PG pin floating.

nRESET

nRESET is not functional in CMI 104. Leave the nRESET pin floating.

nRESET_AUX1

nRESET_AUX1 is asserted low when any regulator is out of regulation. The reset timing is 1991us. Note that in the default configuration, nRESET_AUX1 goes low when the IC enters Sleep mode. If the user requires nRESET_AUX1 to stay high in Sleep mode, write a 1 into register 0x00h, bit 7.

EXT_PG

EXT_PG is used for Buck2 boot voltage. See the Buck2 VID Boot Voltage section above.

nRESET_AUX2

nRESET_AUX2 is used for Buck3 boot voltage. See the Buck3 VID Boot Voltage section above.

MODE

The MODE pin must be tied to ground.

GPIO

The GPIO pin must be tied to ground.

Default Mask Settings

CMI 104 Default Mask Settings								
nRESET	nRESET_AUX1	nRESET_AUX2	VIN_OV	IRQ	POK	Thermal Shutdown	UV	OV
Masked	Masked	Masked	Unmasked	Masked	Masked	Unmasked	Unmasked	Unmasked

Device ID

The CMI 104 Device ID (register 0x7Dh) = 0xDh

I2C Address

The CMI 104 7-bit I2C address is 0x5Ah. This results in 0xB4h for a write address and 0xB5h for a read address.

CMI 109: ACT8870QJ109-T

CMI 109 is optimized for the Starblaze STAR1000/STAR1000P M.3, U.2, and AIC form factor solid state disk (SSD) drive controllers. It is designed to operate from a 3.3V input voltage.

STAR1000 Configuration

The following table shows how to connect the ACT8870QJ109 outputs to the STAR1000/STAR1000P.

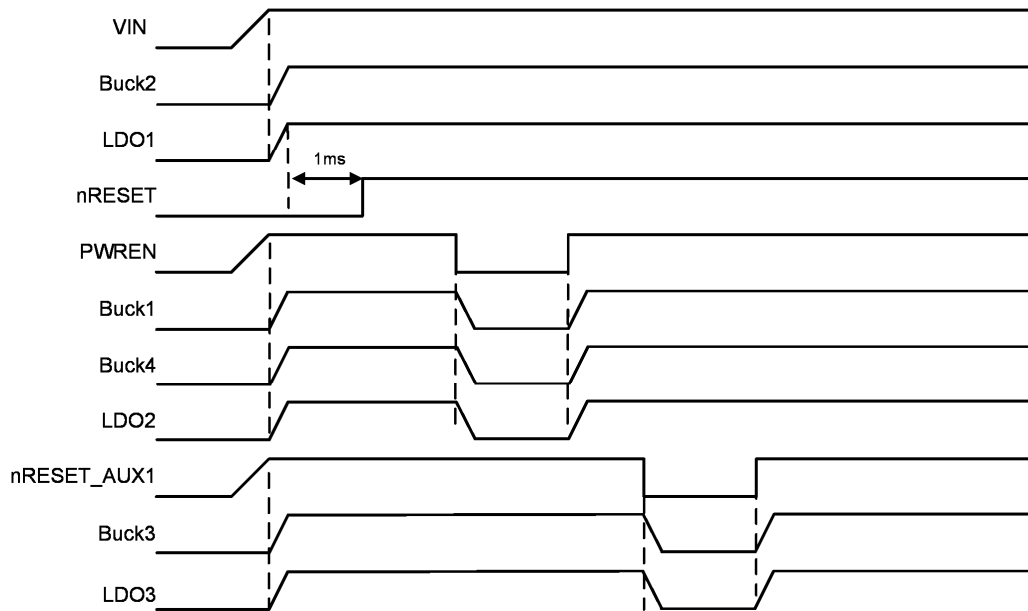
	STAR1000 / STAR1000P Voltage (V)	STAR1000 / STAR1000P Connections
EXT_PG	n/a	EXT_PG sets Buck4 startup output voltage. Connect to VIO_IN or AGND.
nRESET_AUX1 Input Setting	n/a	System Reset. Connects to RESETN pin.
nRESET_AUX2 Input Setting	n/a	Buck3/LDO3 Enable Control. Connects to the GPIO_2 output.
PWREN	n/a	Buck1/Buck4/LDO2 Enable Control. Connects to the GPIO_1 output.
IRQ	n/a	Interrupt to the STAR1000/STAR1000P. Connect to GPIO_5
Buck1	2.7	NFVDD
Buck2	0.9	PER/PSW2
Buck3	1.2	PSW3/PSQ2_PSW3
Buck4	1.2/1.8	VDD_IO_FLASH
LDO1	1.8	PER
LDO2	1.8	DDR_PLL_VDDR
LDO3	2.5	PSW3

Sequencing

Rail	Active Mode Voltage (V)	DVS Voltage (V)	DVS Trigger (V)	Sleep Mode Voltage (V)	DVS slew rate (mV/us)	Current Limit Setting (A)	Sequencing Input Trigger	StartUp Delay (us)	Soft-Start (us)
Buck2	0.9	0.9	N/A	N/A	3.5	3.5	VIN_UVLO	0	800
LDO1	1.8	N/A	N/A	N/A	N/A	0.8	VIN_UVLO	0	330
Buck1	2.7	2.7	N/A	N/A	3.5	5.3	PWREN	0	500
Buck3	1.2	1.2	N/A	N/A	3.5	3	nRESET_AUX1	0	500
Buck4	1.8	1.2	EXT_PG	N/A	3.5	3.5	PWREN	0	500
LDO2	1.8	N/A	N/A	N/A	N/A	0.2	PWREN	0	165
LDO3	2.5	N/A	N/A	N/A	N/A	0.2	nRESET_AUX1	0	165

Startup

CMI 109 Startup



SLEEP Mode

CMI 109 does not use SLEEP Mode.

DVS Mode

CMI 109 can DVS Buck4. EXT_PG is the DVS control input. When EXT_PG = L, Buck4 = 1.8V. When EXT_PG = H, Buck4 = 1.2V

POK Thresholds

POK_UV = 2.8V

POK_OV = 3.6V

PG

The PG pin is not functional with CMI 109. Leave the PG pin floating.

POK

The POK pin is not functional with CMI 109. Leave the POK pin floating.

EXT_EN

The EXT_EN pin is not functional with CMI 109. Leave the EXT_EN pin floating.

nRESET

nRESET is triggered from LDO1. It goes high 1ms after LDO1 goes into regulation. After power up, set register 0x00h to a value of 0x20h to prevent nRESET from asserting low during normal operation. This is required because different outputs are turned on and off in normal operation.

nRESET_AUX1

nRESET_AUX1 is the enable input for Buck3 and LDO3. It is active high.

EXT_PG

EXT_PG is the DVS control input for Buck4. When EXT_PG = L, Buck4 = 1.8V. When EXT_PG = H, Buck4 = 1.2V

nRESET_AUX2

The nRESET_AUX2 pin is not functional with CMI 109. Leave the nRESET_AUX2 pin floating.

MODE

The MODE pin must be tied to ground.

GPIO

The GPIO pin must be tied to ground.

Default Mask Settings

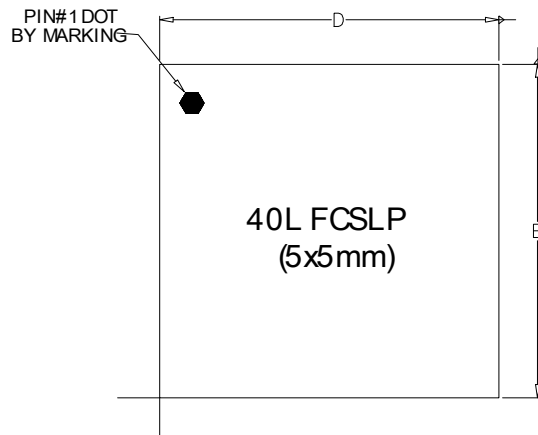
CMI 109 Default Mask Settings								
nRESET	nRESET_AUX1	nRESET_AUX2	VIN_OV	IRQ	POK	Thermal Shutdown	UV	OV
Masked	Masked	Masked	Unmasked	Masked	Masked	Unmasked	Unmasked	Unmasked

Device ID

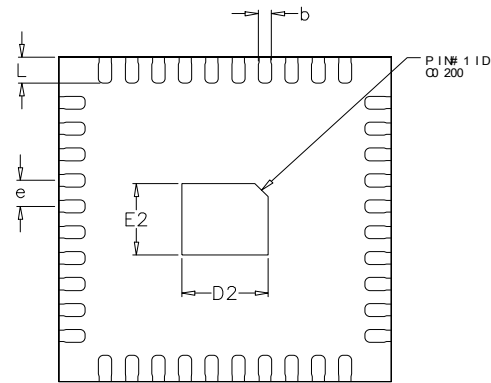
The CMI 109 Device ID (register 0x7Dh) = 0x12h

I2C Address

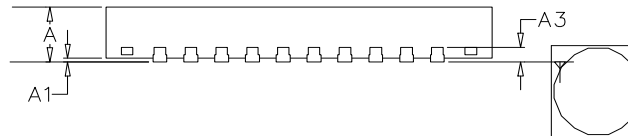
The CMI 109 7-bit I2C address is 0x5Ah. This results in 0xB4h for a write address and 0xB5h for a read address.

PACKAGE OUTLINE AND DIMENSIONS QFN55-40


Top View



Bottom View



Side View

SYMBOL	DIMENSION IN MILLIMETERS		DIMENSION IN INCHES	
	MIN	MAX	MIN	MAX
A	0.800	0.900	0.031	0.035
A1	-	0.050	-	0.002
A3	0.203 REF		0.008 REF	
D	4.950	5.050	0.195	0.199
E	4.950	5.050	0.195	0.199
D2	1.250	1.350	0.049	0.053
E2	1.050	1.150	0.041	0.045
b	0.150	0.250	0.006	0.010
e	0.400 BSC		0.016 BSC	
L	0.350	0.450	0.014	0.018

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